

42ND INTERNATIONAL CONFERENCE ON HIGH ENERGY PHYSICS

18-24 July 2024

A large-area prototype SiPM readout plane
for the ePIC-dRICH detector at the EIC

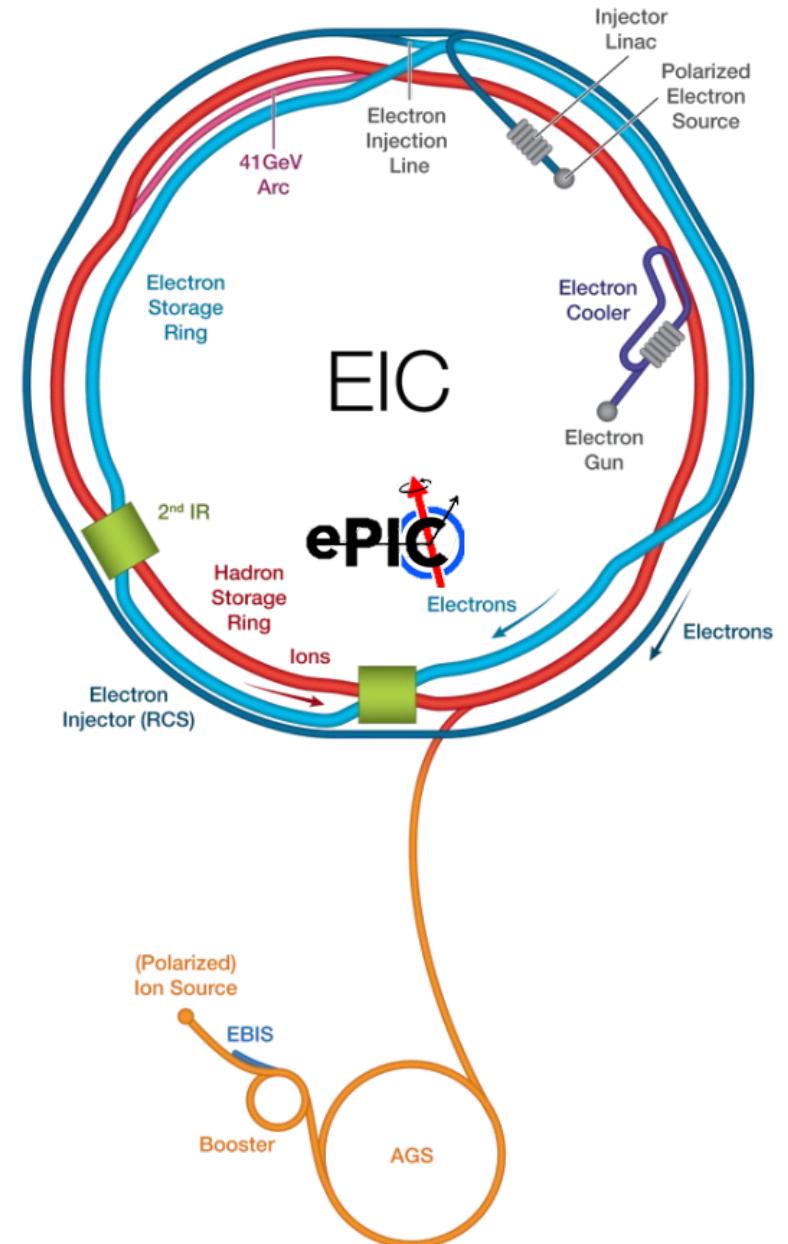


Luigi Rignanese on behalf of the **ePIC dRICH** collaboration



Outline:

- The **Electron-Ion Collider** and the **ePIC** detector
- **SiPMs and radiation damage**
- **Prototype**
- **Test beam results**



The Electron-Ion Collider



The major US project in the field of nuclear physics

- Operating in the early '30s

The world's first collider for

- Polarized electron-proton (and light ions)
- Electron-nucleus collisions

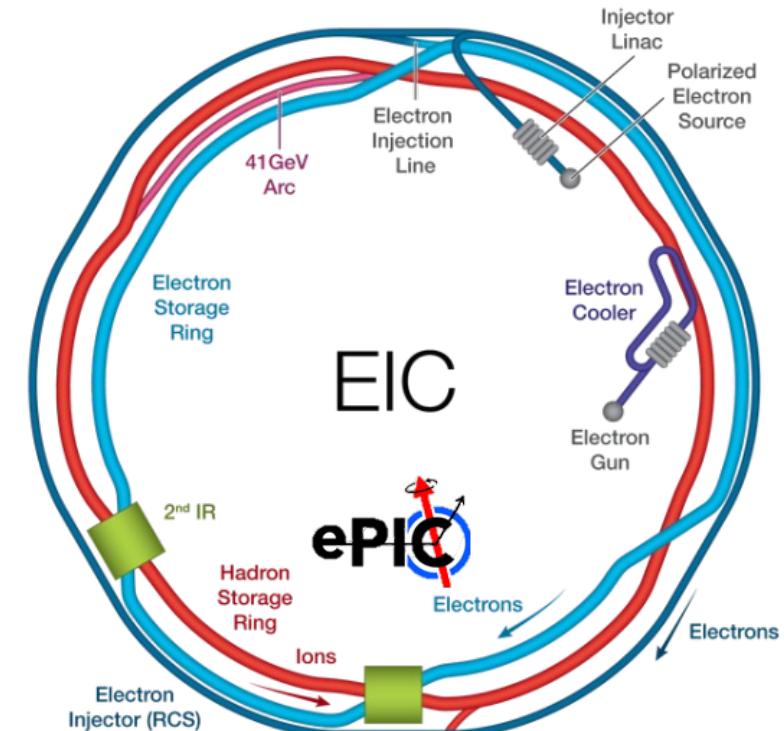
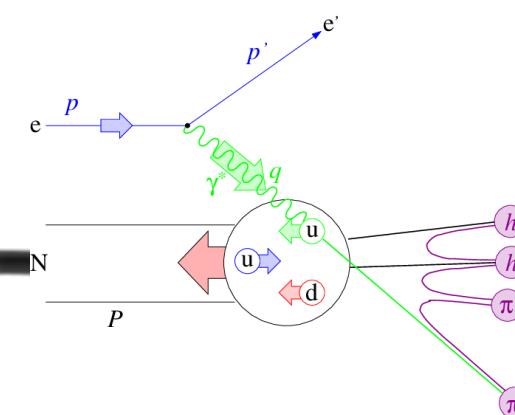
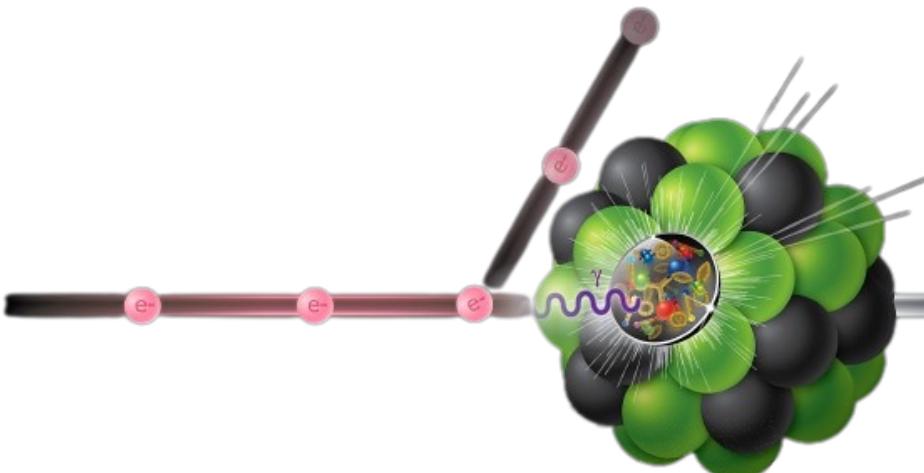
High Luminosity: $10^{34} \text{ cm}^2\text{s}^{-1}$

Wide energy span → 20-140 GeV

Inclusive/semi-inclusive DIS

- understand origin of mass & spin of the nucleons

3D images of the nuclear structure (GPD)



protons and nuclei
RHIC infrastructure

polarized electrons
new accelerator complex and storage ring

Magnet

- New 1.7 T SC solenoid, 2.8 m bore diameter

Tracking

- Si Vertex Tracker MAPS wafer-level stitched sensors (ALICE ITS3)
- Si Tracker MAPS barrel and disks
- Gaseous tracker: MPGDs (μ RWELL, MMG) cylindrical and planar

PID

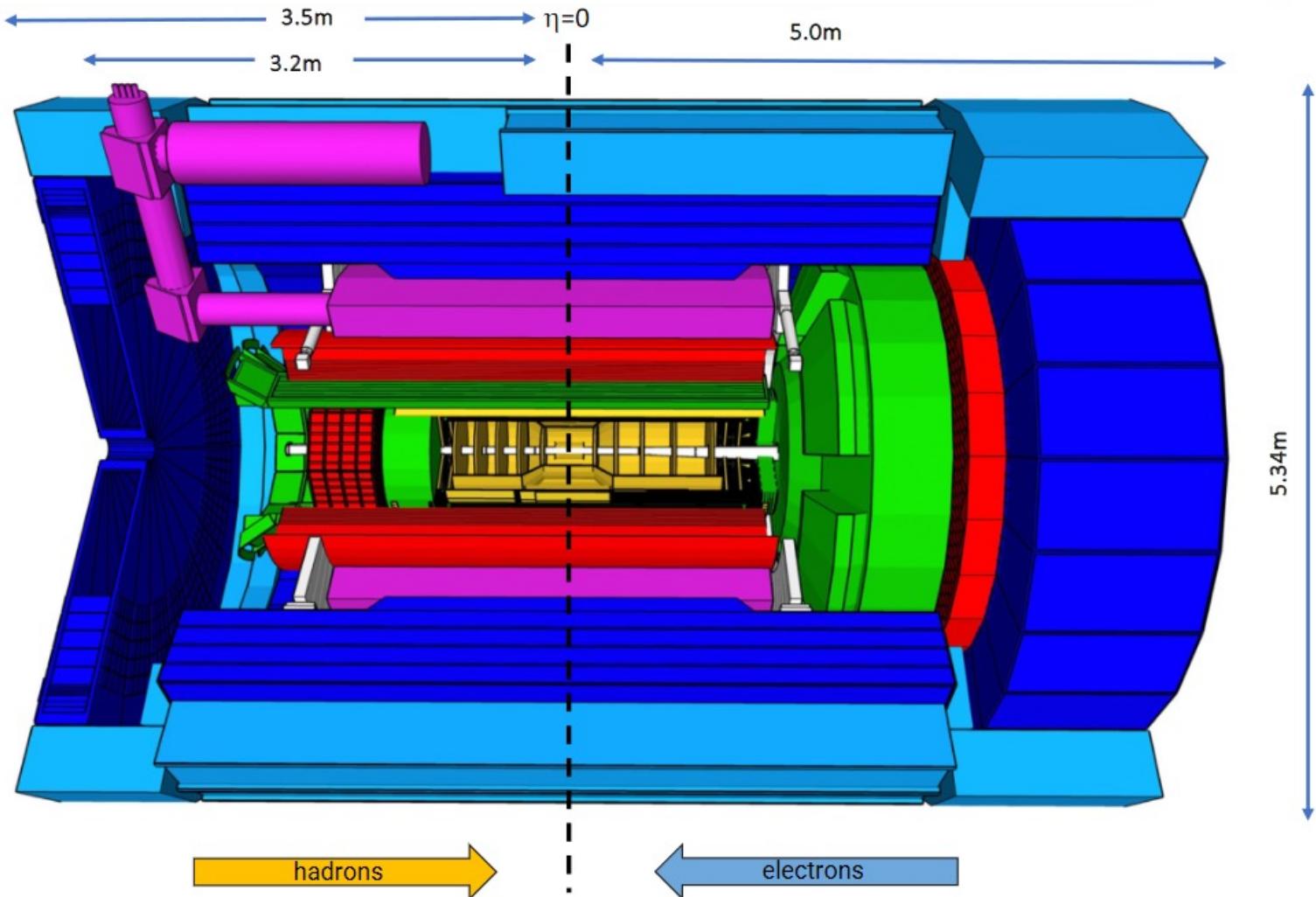
- high performance DIRC (hpDIRC)
- dual RICH (aerogel + gas) (forward)
- proximity focussing RICH (backward)
- ToF using AC-LGAD (barrel+forward)

EM Calorimetry

- imaging EMCAL (barrel)
- W-powder/SciFi (forward)
- PbWO_4 crystals (backward)

Hadron calorimetry

- FeSc (barrel, re-used from sPHENIX)
- Steel/Scint – W/Scint (backward/forward)



Magnet

- New 1.7 T SC solenoid, 2.8 m bore diameter

Tracking

- Si Vertex Tracker MAPS wafer-level stitched sensors (ALICE ITS3)
- Si Tracker MAPS (forward)
- Gaseous tracker: MPGDs (URWELL, MM3) cylindrical and planar

"Excellent particle identification (PID) is required to separate $\pi/K/p$ at the level of 3σ up to 50 GeV/c in the forward region, up to 10 GeV/c in the central detector region, and up to 7 GeV/c in the backward region"

PID

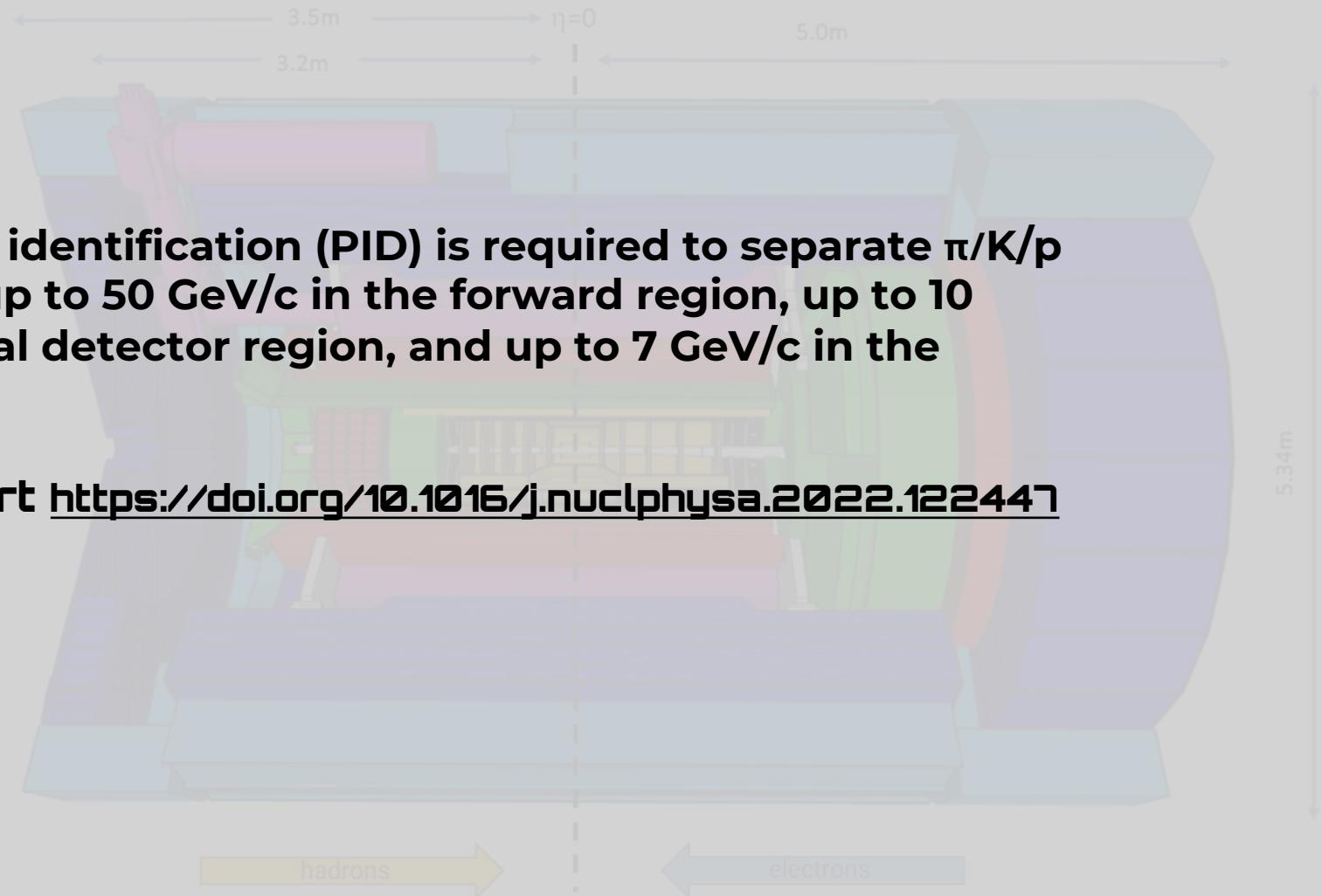
- high performance CTR (pPbR)
- dual RICH (aerogel + gas) (forward)
- proximity focussing (backward)
- ToF using AC-LGAs (barrel, forward)

EM Calorimetry

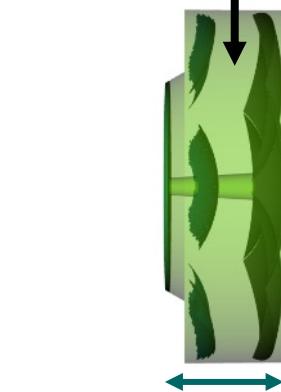
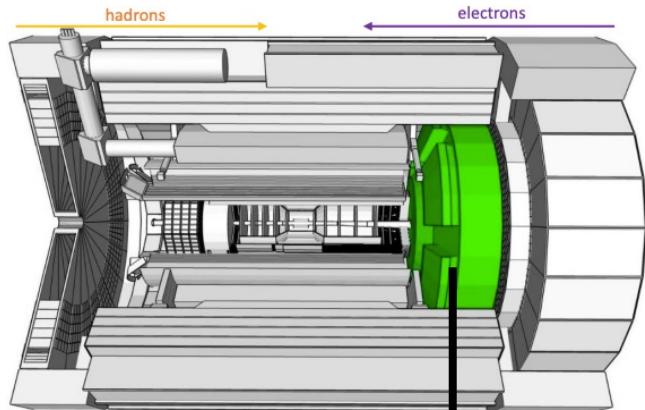
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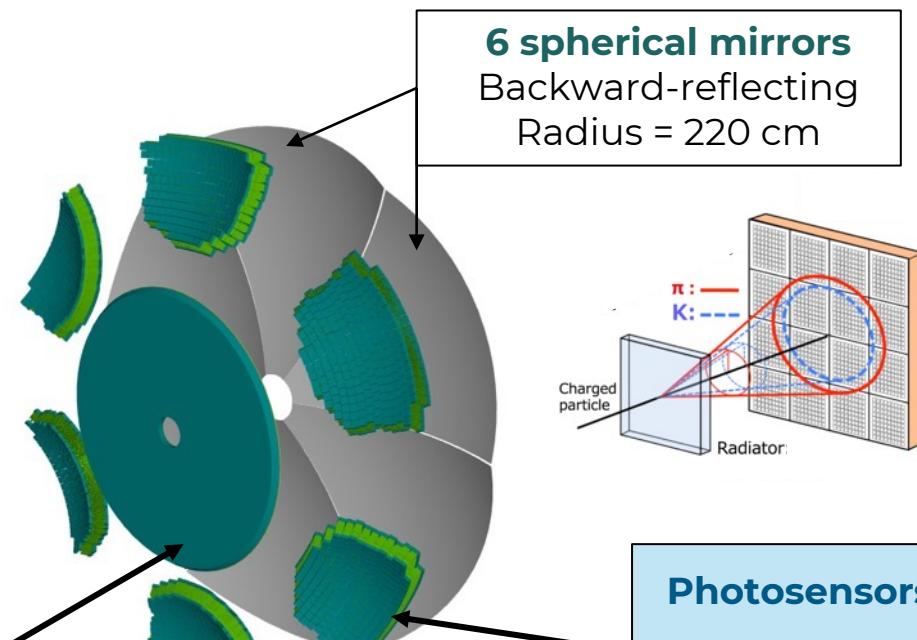
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- Steel/Scint – W/Scint (backward/forward)



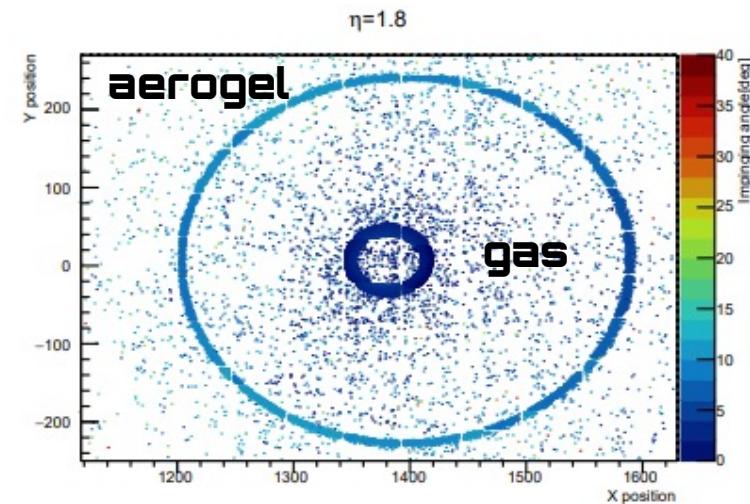
The dual-radiator (dRICH)



Compact and **cost-effective** solution for **broad momentum** (3-50 GeV/c) coverage at forward rapidity **π/K 3 σ separation at 50 GeV/c** and **wide acceptance** (+- 300 mrad/ 1.5 < η < 3.5)

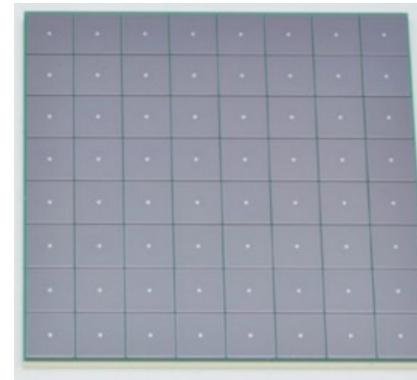


Photosensors 3x3 mm² pixels 0.5 m² per sector in 1 T magnetic field and radioactive environnement for low light levels.



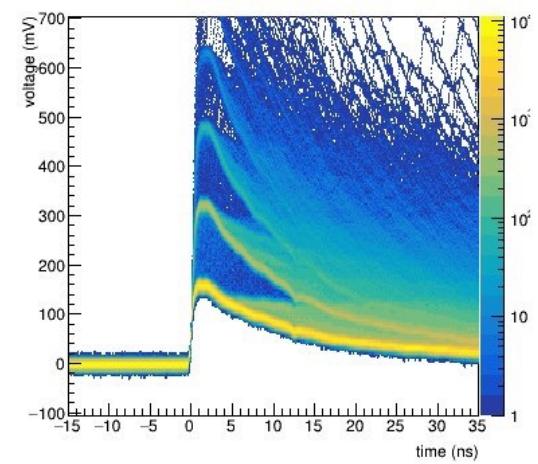
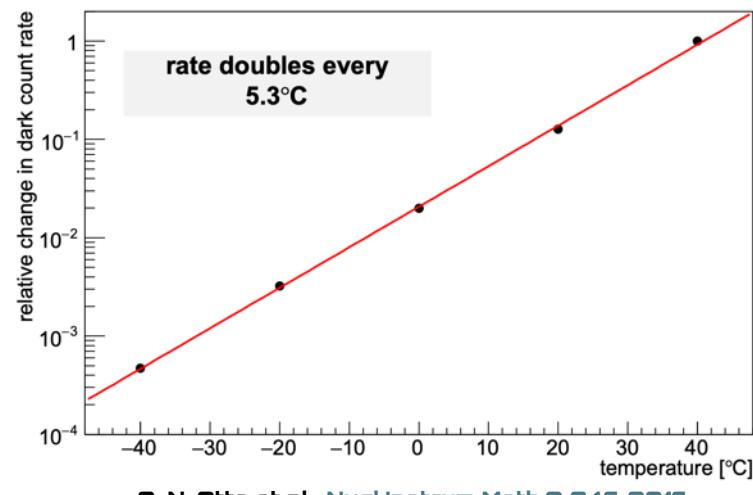
SiPMs are the best candidates

- **Small and cheap**
- **Insensitive to magnetic field**
- **High** photo-detection efficiency (**PDE**)
- High gain-**single photon** detection
- **Low voltage** operation
- Excellent **timing** performance



But:

- x **High DCR** @ room temperature
 - x **Low radiation tolerance**
- DCR increases with dose**





Sub ns time resolutions allow **coincidence** cuts that greatly reduces **DCR** contribution in the measurements



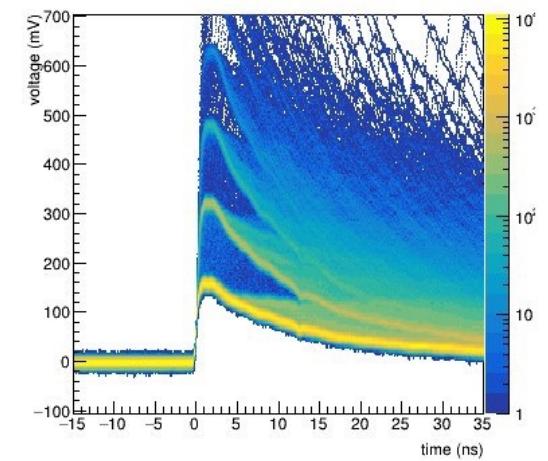
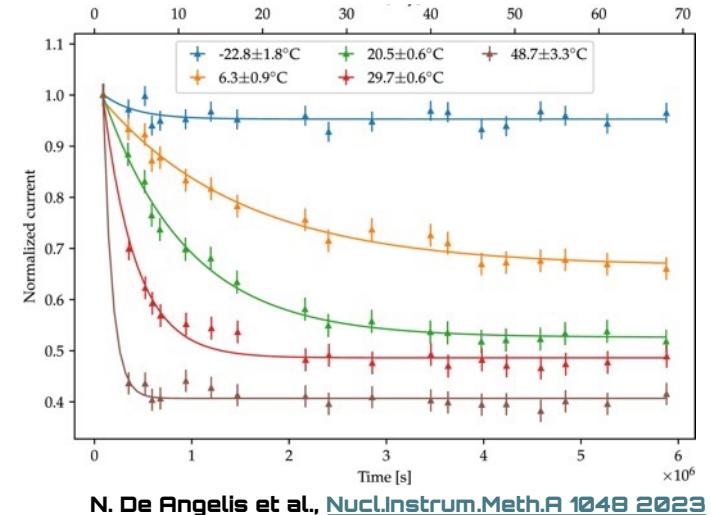
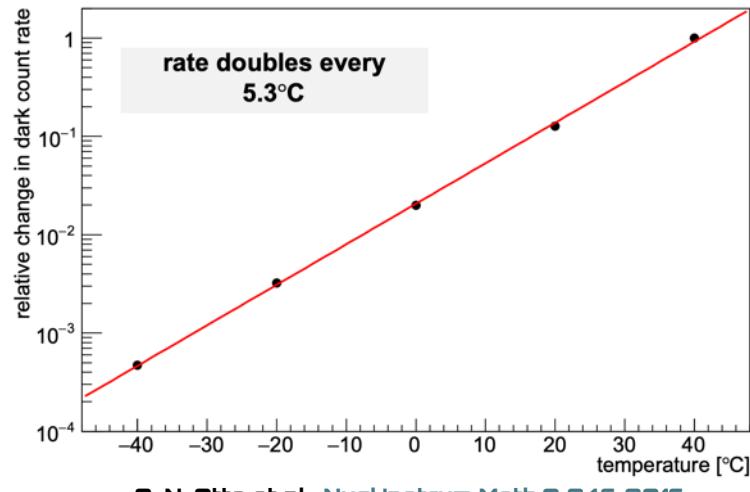
Annealing techniques (**high temperature process**) to recover **DCR** performance loss



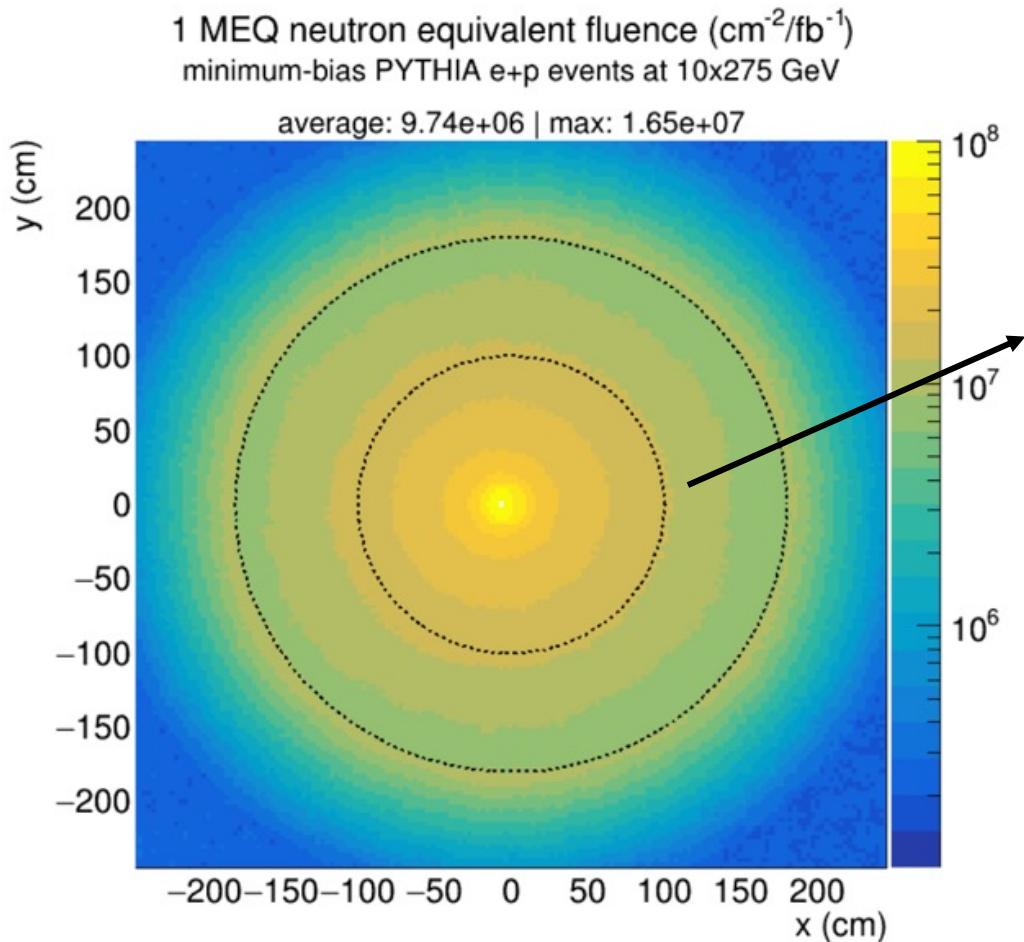
Cooling the sensors down to **-30° C** **reduces** the **DCR** by a factor ~ 100

But:

- x **High DCR** @ room temperature
- x **Low radiation tolerance**
- DCR increases with dose**



Radiation levels on the dRICH



n_{eq} = 1-MeV neutron equivalent (NIEL model)

dRICH photosensors location:

mean $\approx 9.7 \times 10^6 n_{\text{eq}}/\text{cm}^2$ per fb^{-1}

max $\approx 1.7 \times 10^7 n_{\text{eq}}/\text{cm}^2$ per fb^{-1}
(including bkg)

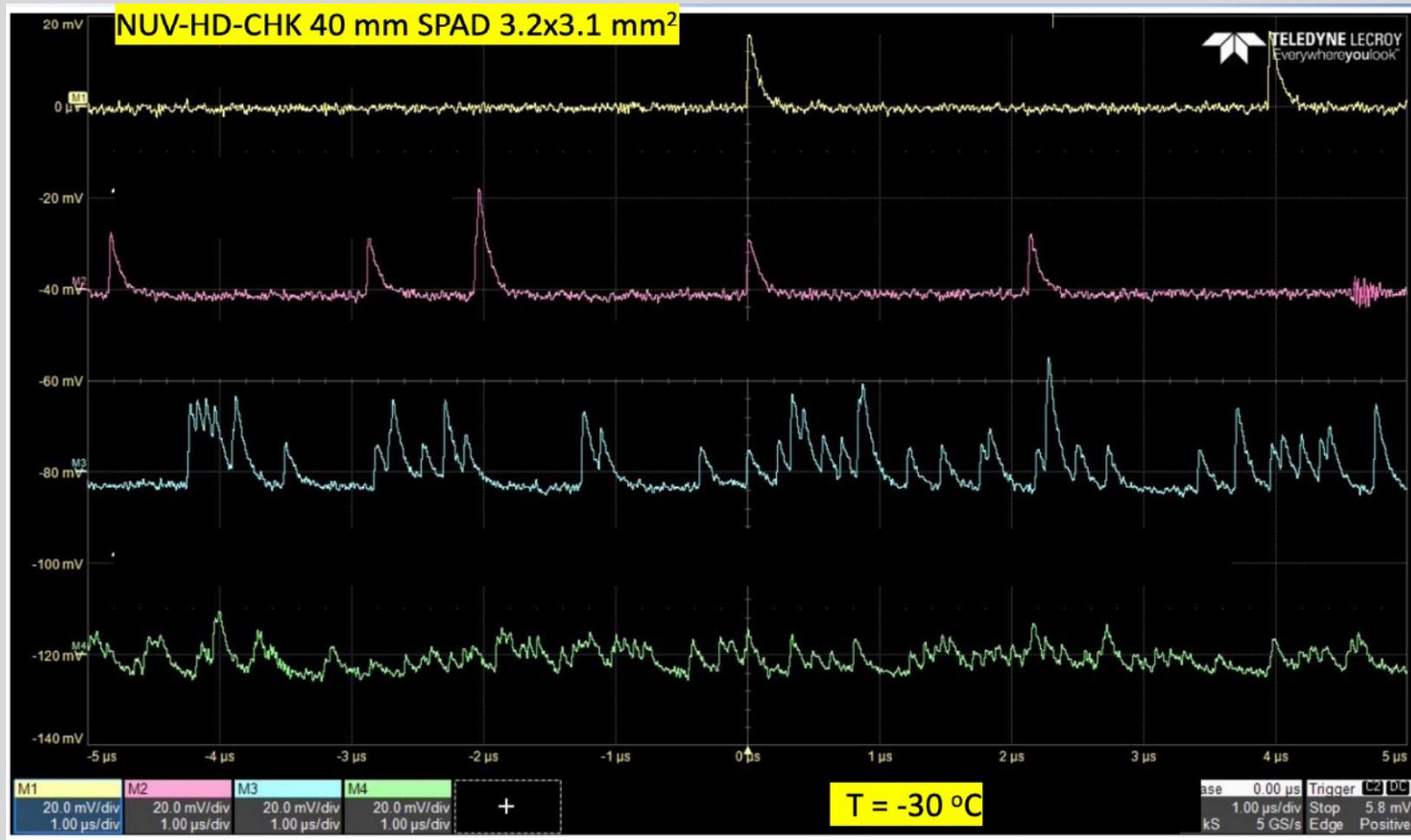
Integrated luminosity and radiation levels

- 10 fb^{-1} for **most** of the **physics topics**
- 10^2 fb^{-1} **GPD** and statistically eager topics
- 10^3 fb^{-1} may **never** be reached

$<10^9 n_{\text{eq}}/\text{cm}^2$
 $<10^{10} n_{\text{eq}}/\text{cm}^2$
 $<10^{11} n_{\text{eq}}/\text{cm}^2$



Radiation levels on the dRICH



Equivalent (NIEL model)

new

Location:

bar fb-1

$10^9 \text{ n}_{\text{eq}}/\text{cm}^2$

$10^{10} \text{ n}_{\text{eq}}/\text{cm}^2$
(SP affected)

Physics topics

particularly eager topics

$10^{11} \text{ n}_{\text{eq}}/\text{cm}^2$
(baseline affected)

$<10^9 \text{ n}_{\text{eq}}/\text{cm}^2$

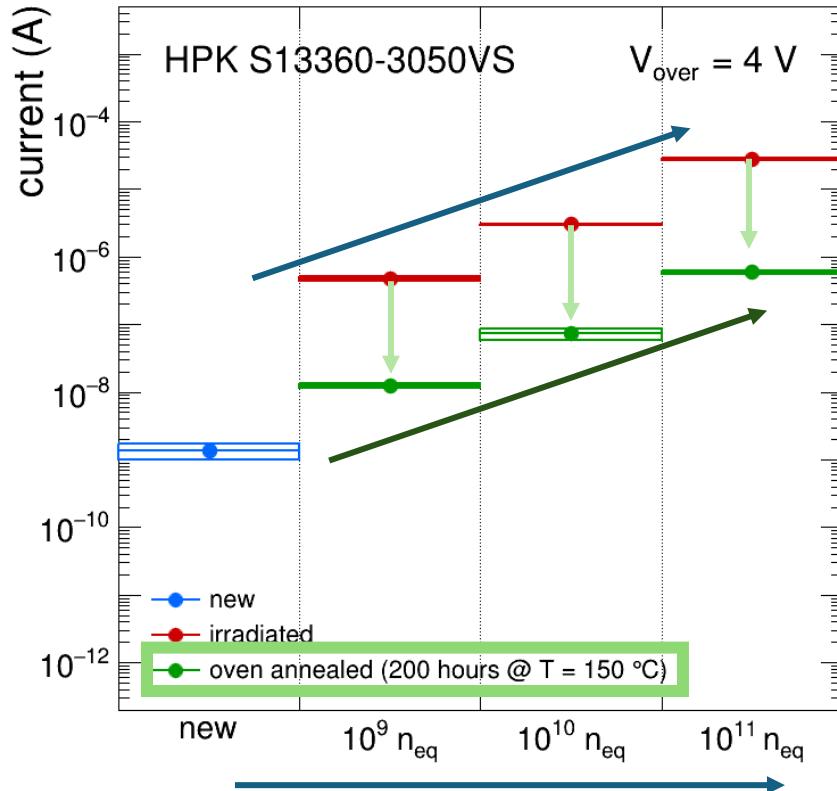
$<10^{10} \text{ n}_{\text{eq}}/\text{cm}^2$

$>10^{11} \text{ n}_{\text{eq}}/\text{cm}^2$



SiPMs radiation damage studies and annealing (2021)

Irradiation campaigns with protons at TIFPA (TN)

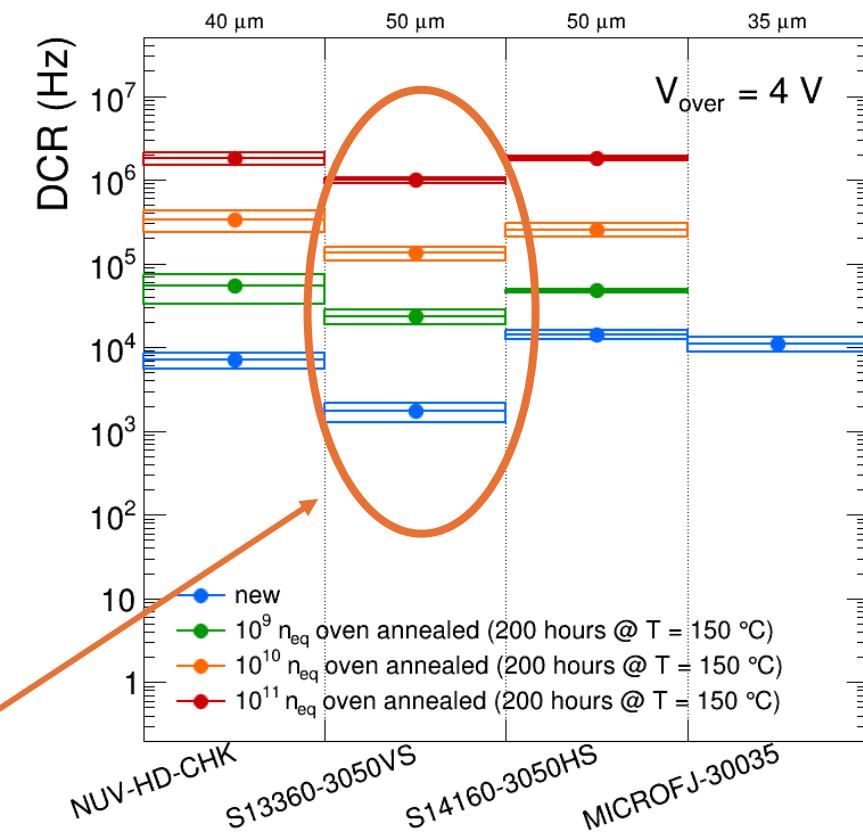


Linear **increase** of dark current/**DCR** with the dose

~50x reduction of dark current/**DCR** with 150° C oven **annealing**

Residual increase in **DCR** is **proportional** to the dose

All sensors behave similarly but **HAMATSU s13360-3050** shows the **lowest DCR** and **best PDE**

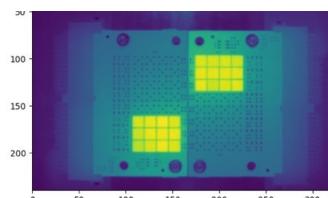
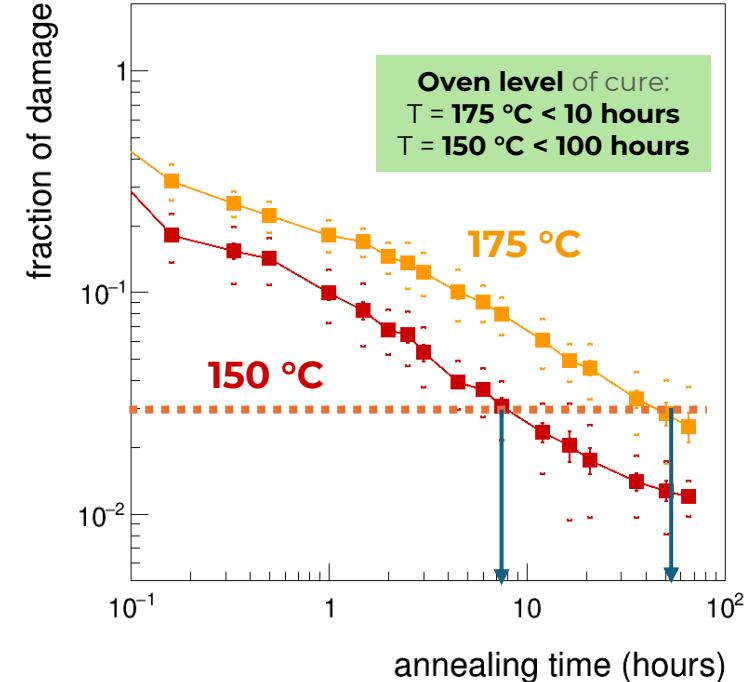
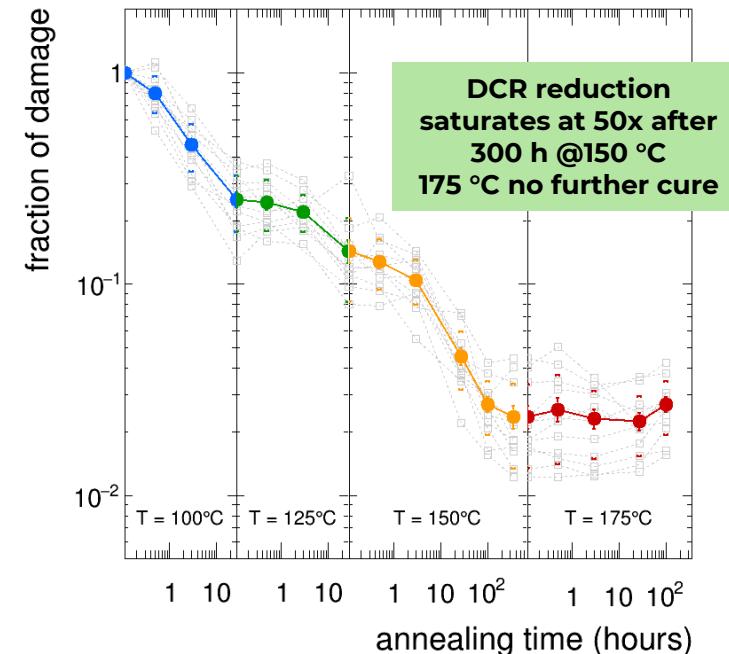
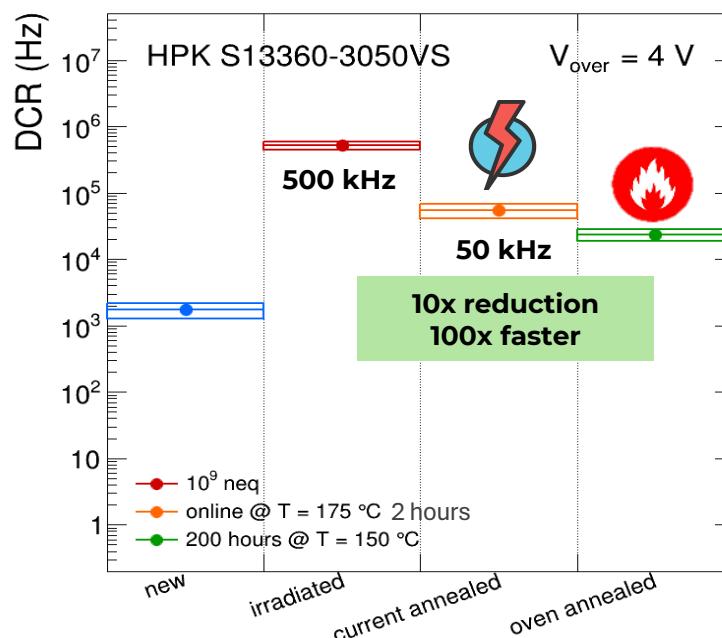


Measurements taken @ -30° C

R. Preghenella et al., [Nucl.Instrum.Meth.A 1056 2023](#)

SiPMs current annealing

Annealing by heating up the sensors. Direct polarized "high" current flowing into the SiPM. 175° C with 10 V and ~100 mA (~ **1 W**) per sensor.

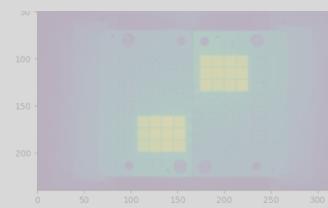
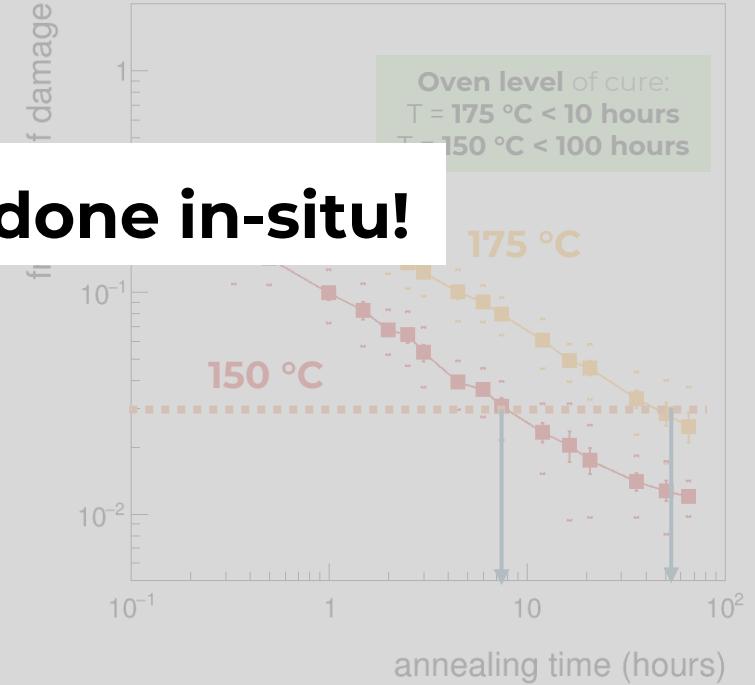
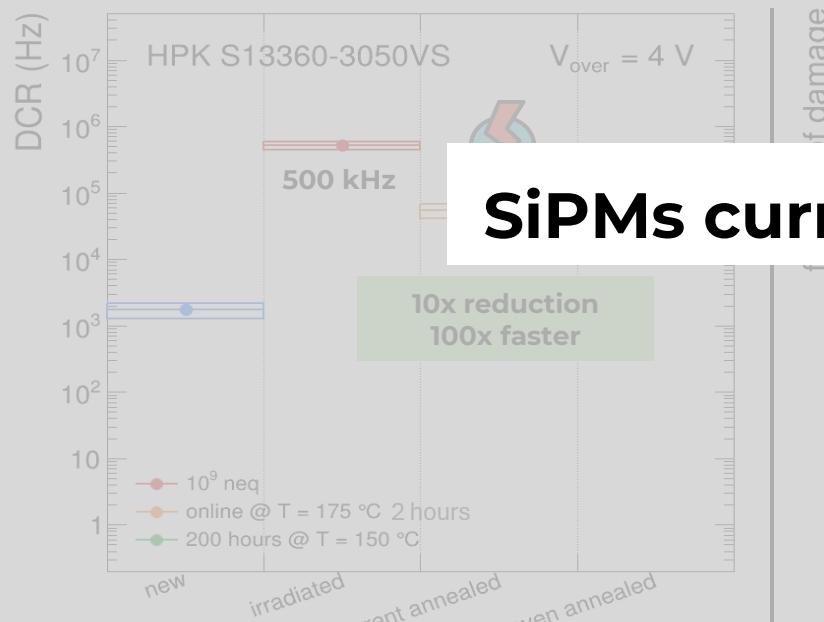


2023/24 test on a large number SiPM. Automated test at different temperatures and time intervals

R. Pregnenella et al., Nucl.Instrum.Meth.A 1056 2023

SiPMs current annealing

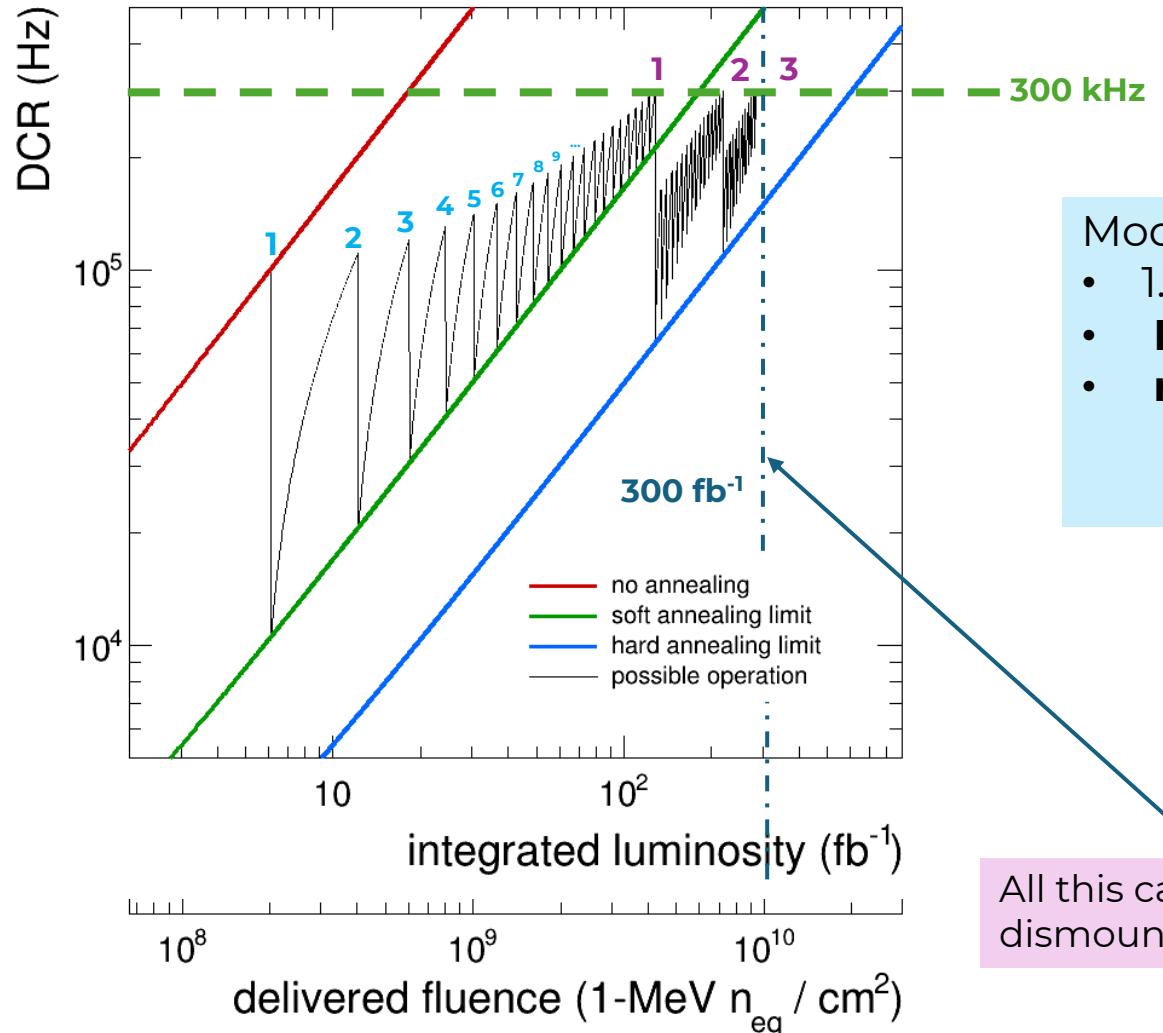
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2023/24 test on a large number SiPM. Automated test at different temperatures and time intervals

SiPMs ageing model

Hamamatsu S13360-3050 @ V_{over} = 4 V, T = -30 C



DCR limit per sensor
SNR and physics program

Model parameters:

- $1.75 \cdot 10^7 n_{\text{eq}} / \text{cm}^2 / \text{fb}^{-1} + 2x \text{ safety factor}$
- **DCR increase (F_d)**: $500 \text{ kHz}/10^9 n_{\text{eq}} / \text{cm}^2$
- **residual DCR (F_a)**:
 - **soft** 2 h@150C annealing = $50 \text{ kHz}/10^9 n_{\text{eq}} / \text{cm}^2$
 - **hard** 100 h@150C annealing = $15 \text{ kHz}/10^9 n_{\text{eq}} / \text{cm}^2$

$$\text{DCR}(K) = \text{DCR}_0 + F_d \cdot (K-1)F_a$$

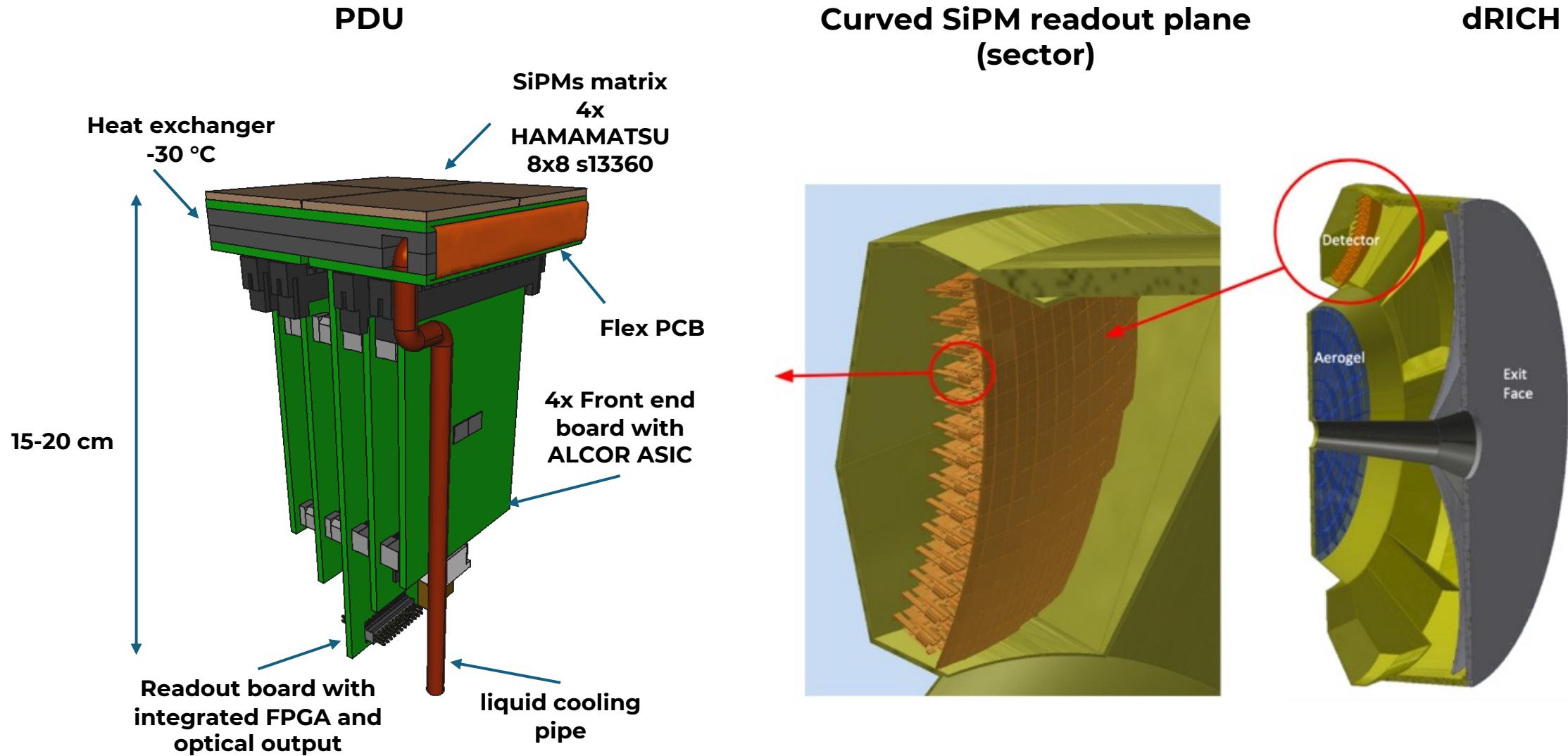
K-1= number of annealing cycles

K soft = 44

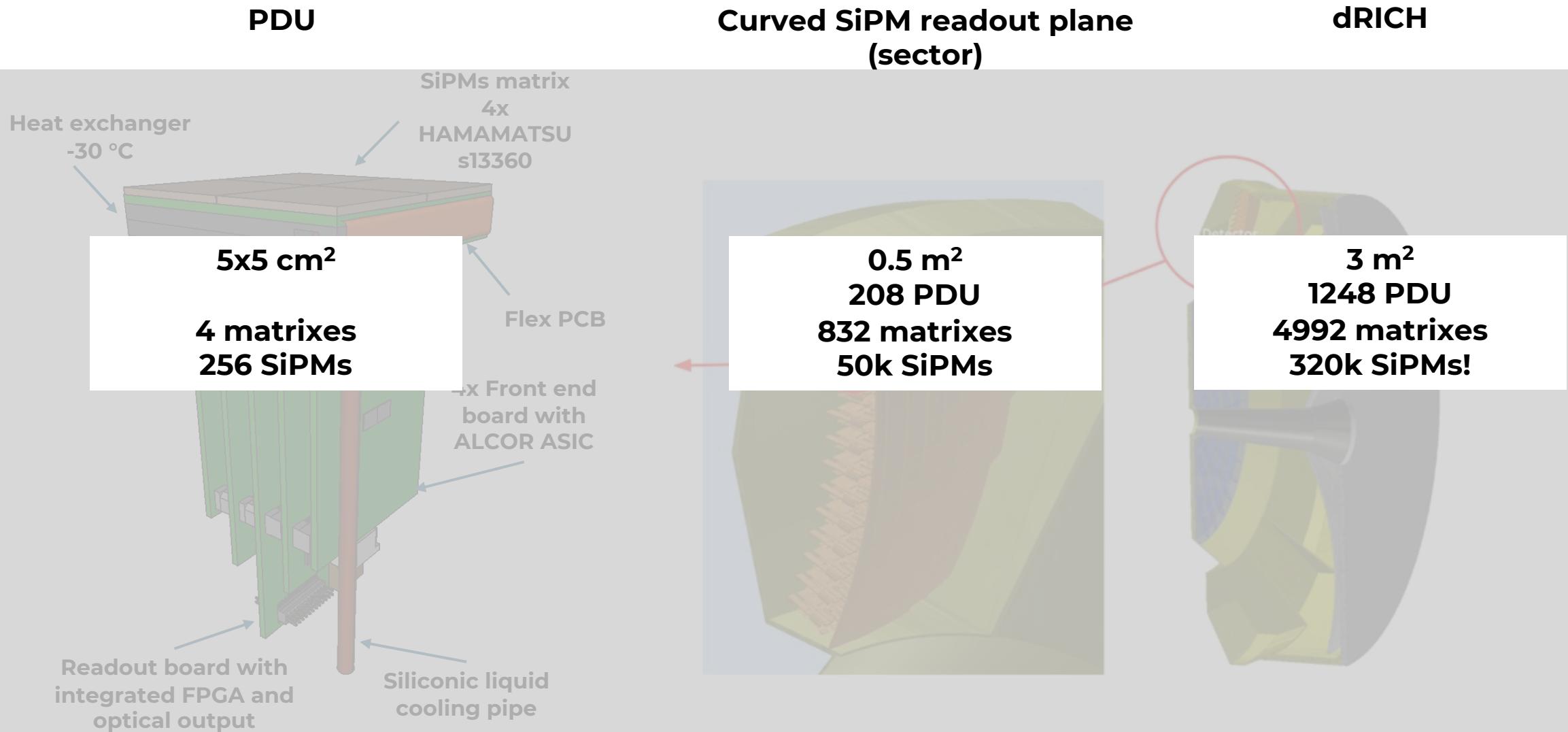
K hard = 3

All this can be done **in-situ**. From here we'll need to dismount the detector (**10 yr** operation)

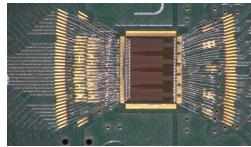
Photodetector design and layout



Photodetector design and layout



ALCOR ASIC by INFN-To



32-pixel matrix mixed signal **ASIC** initially foreseen for **SiPMs** in **cryogenics**

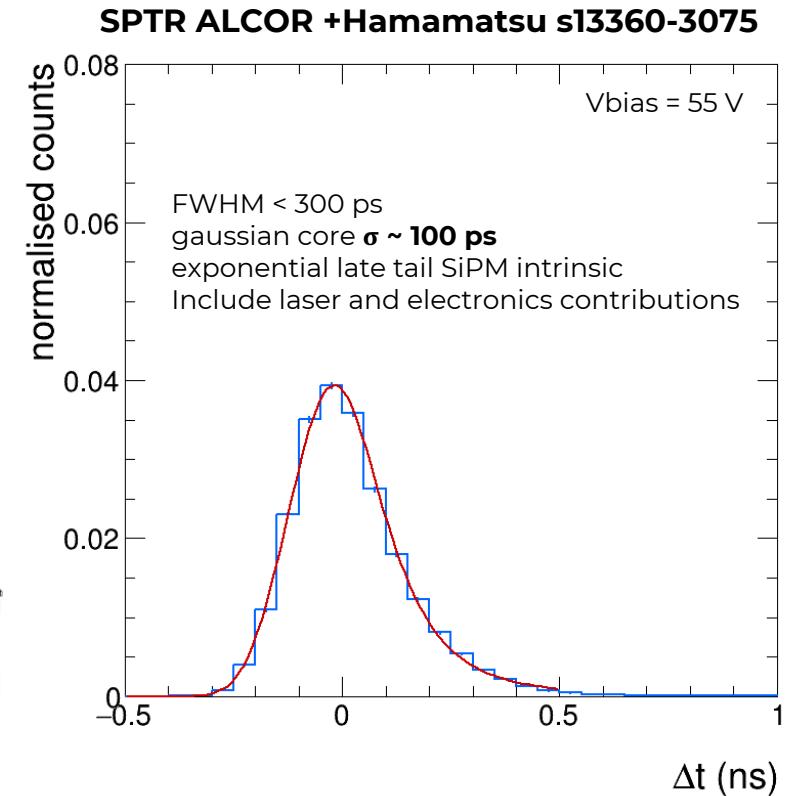
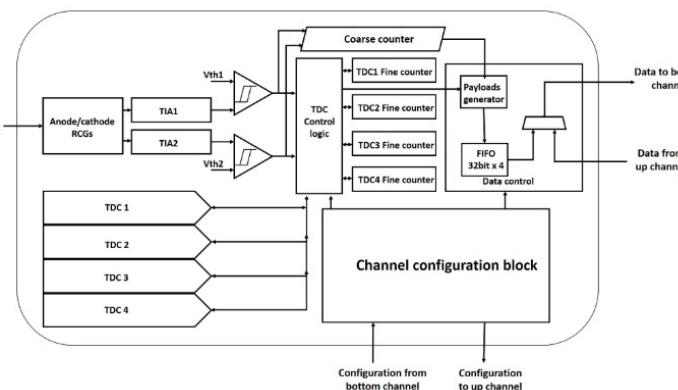
The chip performs **amplification, signal conditioning** and **event digitization** with a fully **digital I/O**

Each **pixel** features

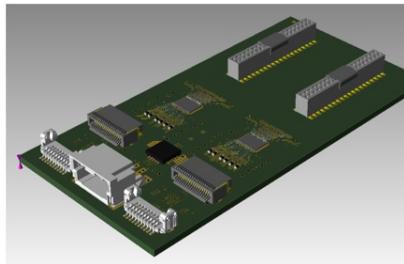
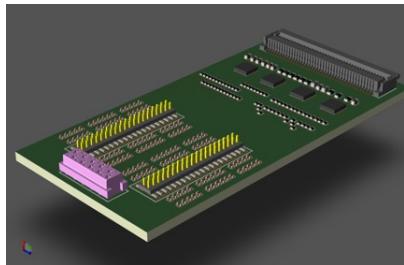
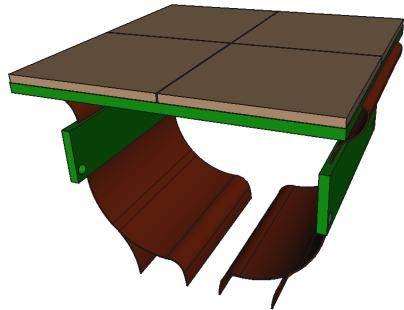
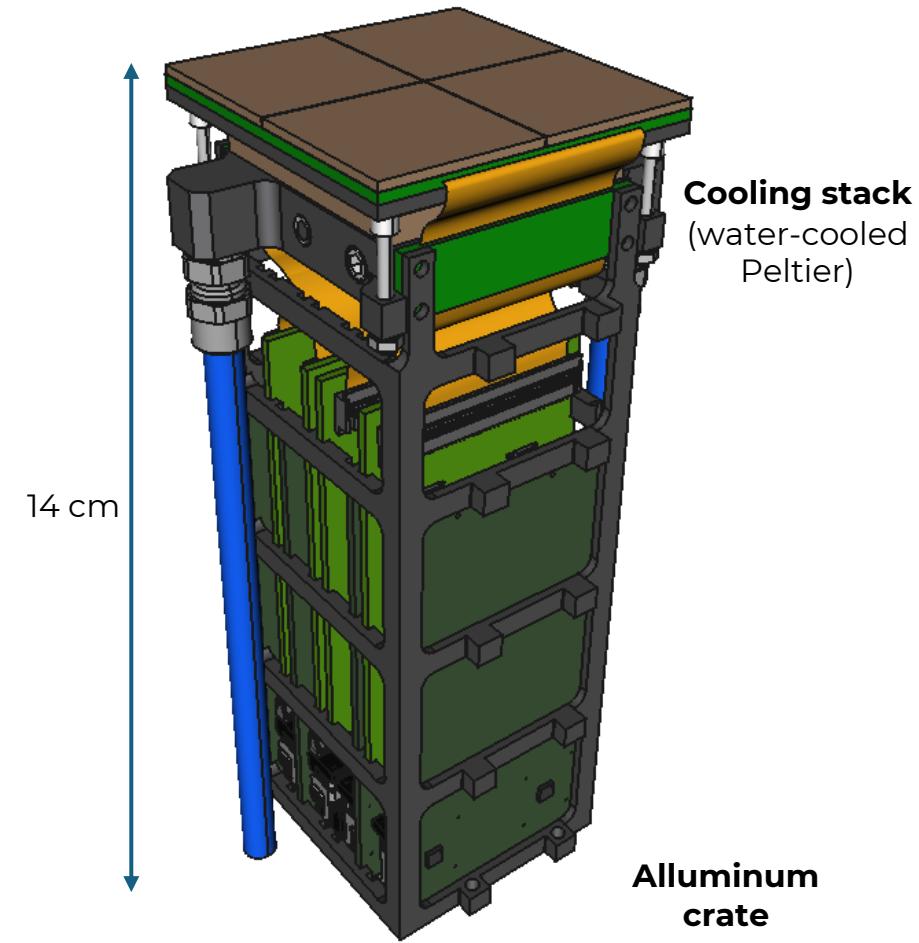
- Regulated common gate **amplifier** ($10\ \Omega$ impedance)
- Post amp TIA for **4 gain settings**
- 2 leading-edge discriminators** with independent **threshold** settings
- 4 TDCs** based on analogue interpolation with **50 ps LSB** (@ 320 MHz)
- 3 triggerless operation** modes:
 - LET** leading edge threshold measurement, high-rate time-stamp
 - ToT** Time-over-Threshold
 - Slew rate**

Fully **digital output** on **4 LVDS TX** data links

SPI-based chip configuration
64-bit event and **status** data



PDU prototype



carrier board

4 matrixes of **8x8**
Hamamatsu S13650 **SiPMs**
(256) on rigid-flex pcb
4 **ntc** sensors on the back

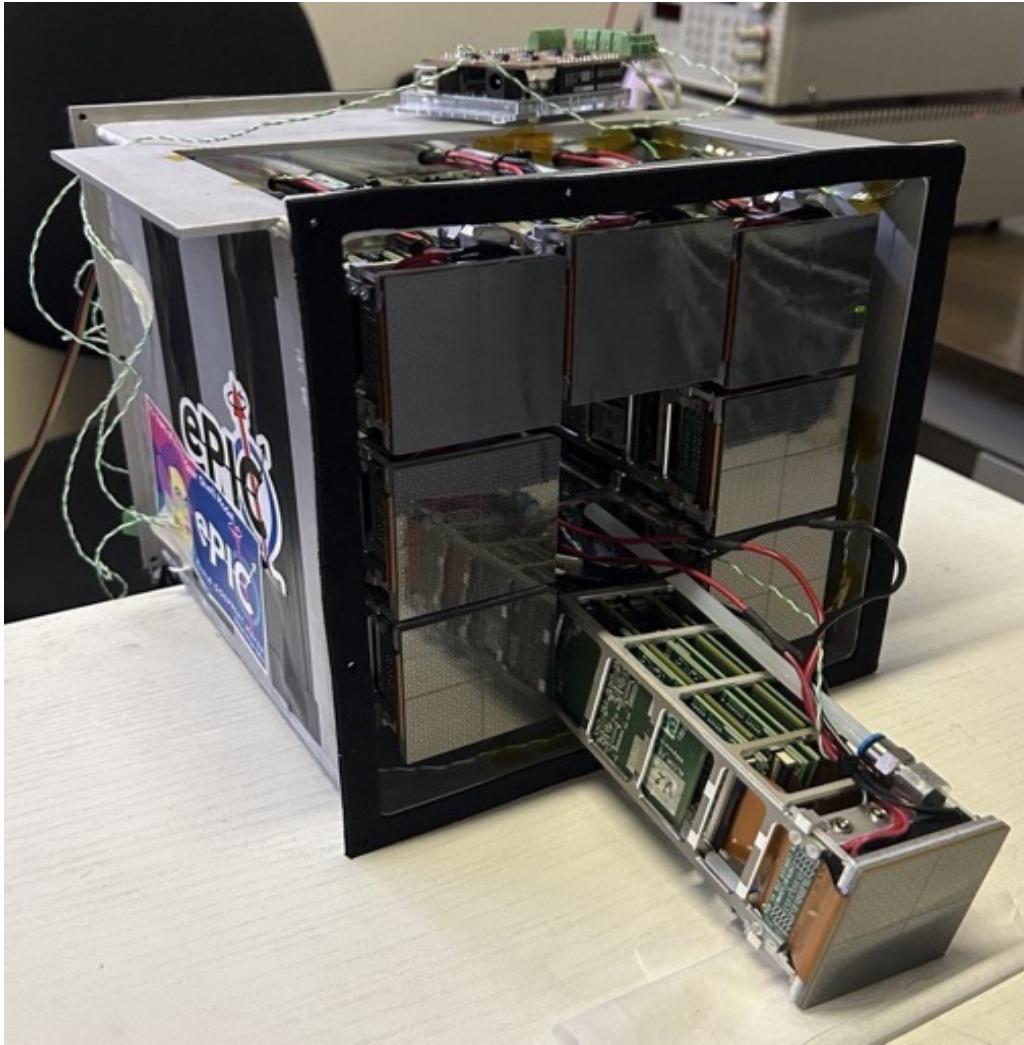
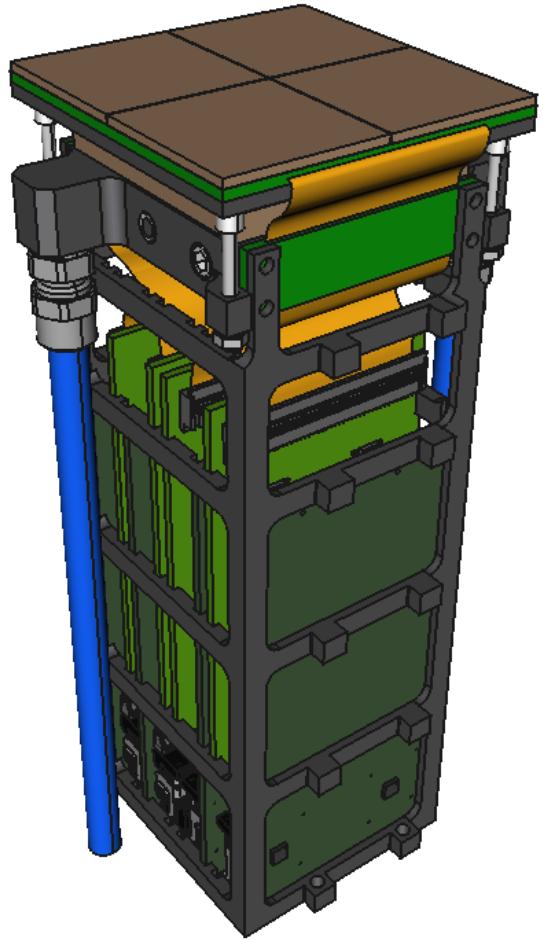
4x adapters

HV regulation
AC coupling to ALCOR

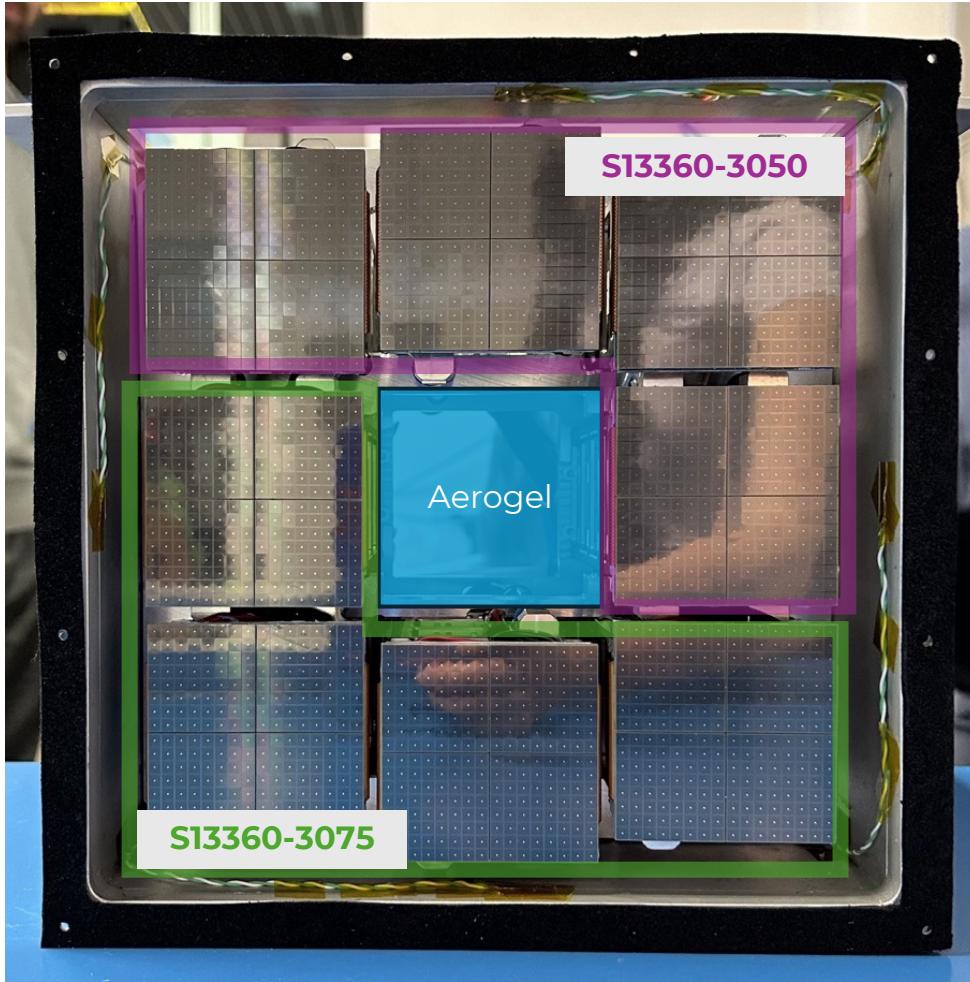
4x FE boards

2x ALCOR-v2 (8 total)
2x Firefly connectors

Detector box prototype



Detector box prototype



20x20x20 cm³

≈400 cm² optical surface (1/10 of a dRICH sector)

2048-Hamamatsu S13360 SiPMs

2 different SPAD sizes (**50** and **75** um)

2 mm dead layer between PDUs

64 ALCOR v2 ASICS

2048 TDC channels electronics

800 Mb/s data rate

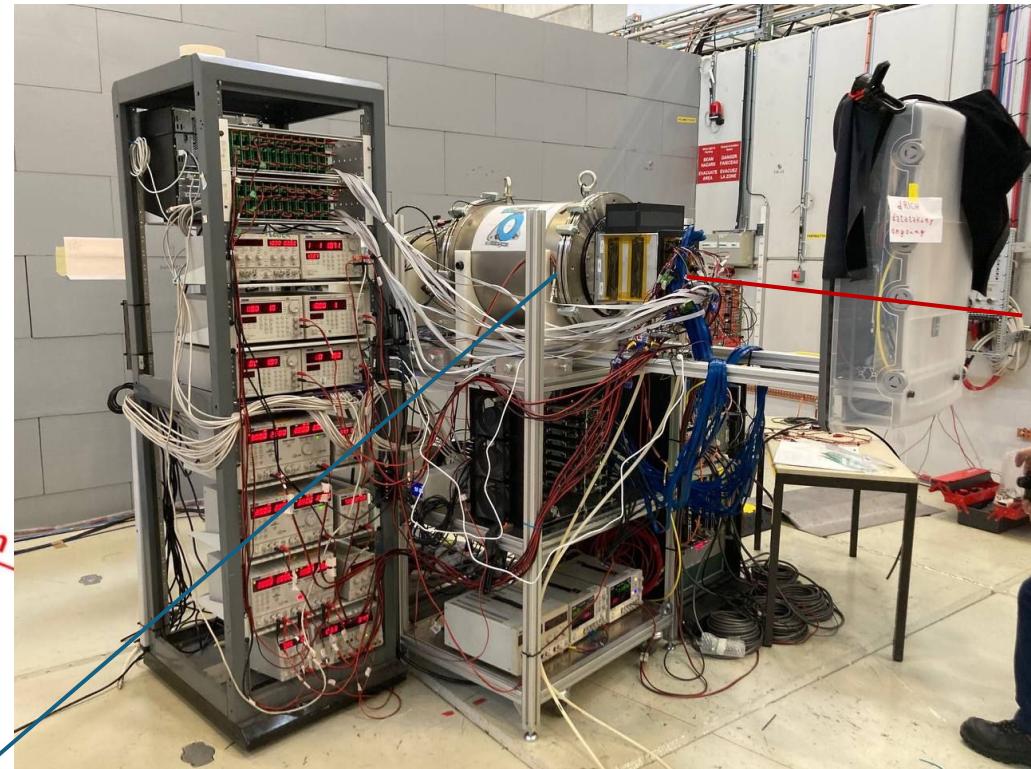
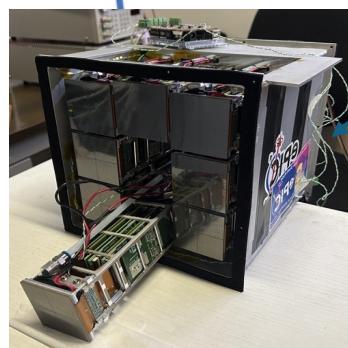
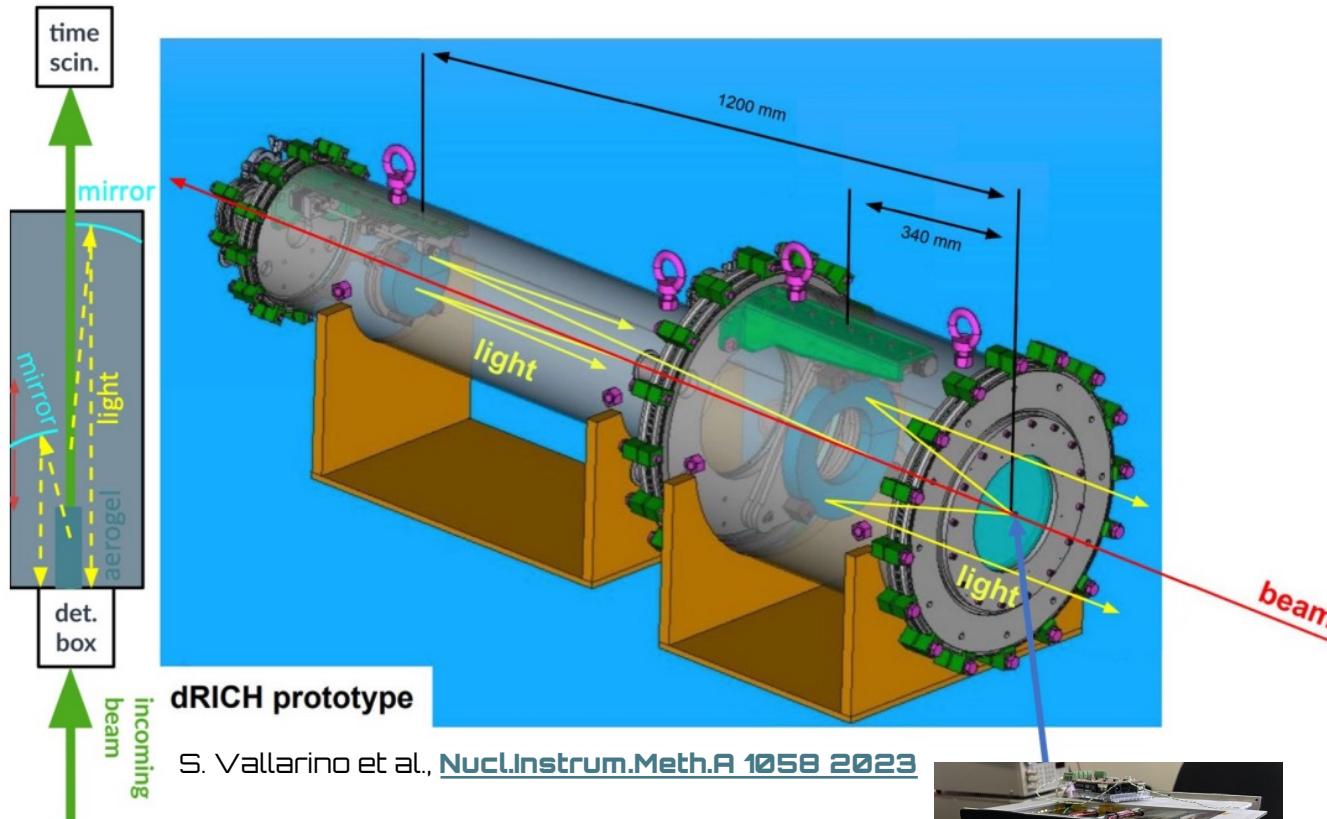
TEC active cooling (≈400 W)

Automatically controlled temp down to **-40 °C**

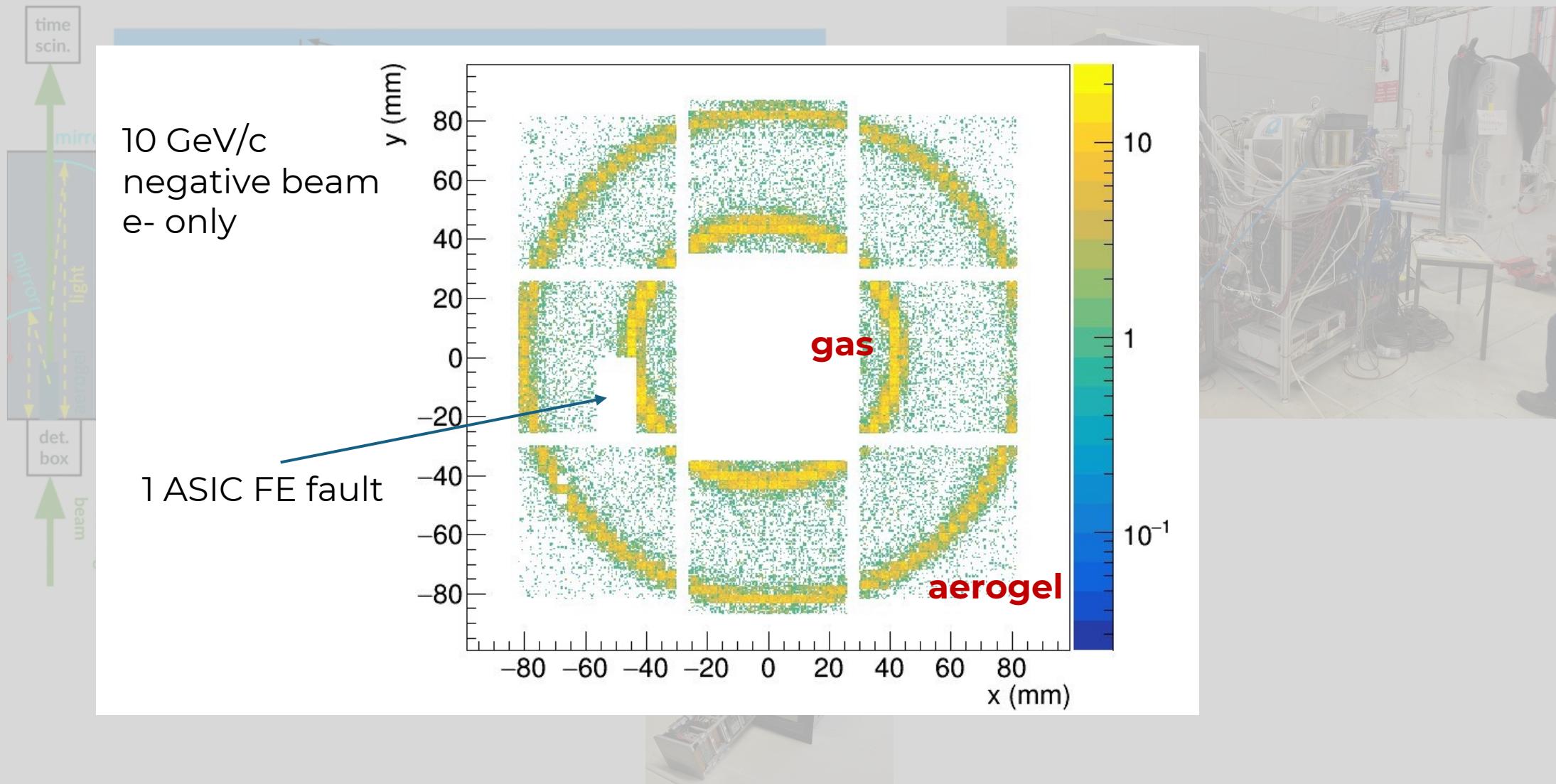
10 °C water cooling



2024 test beam at CERN PS (ended 5 June)

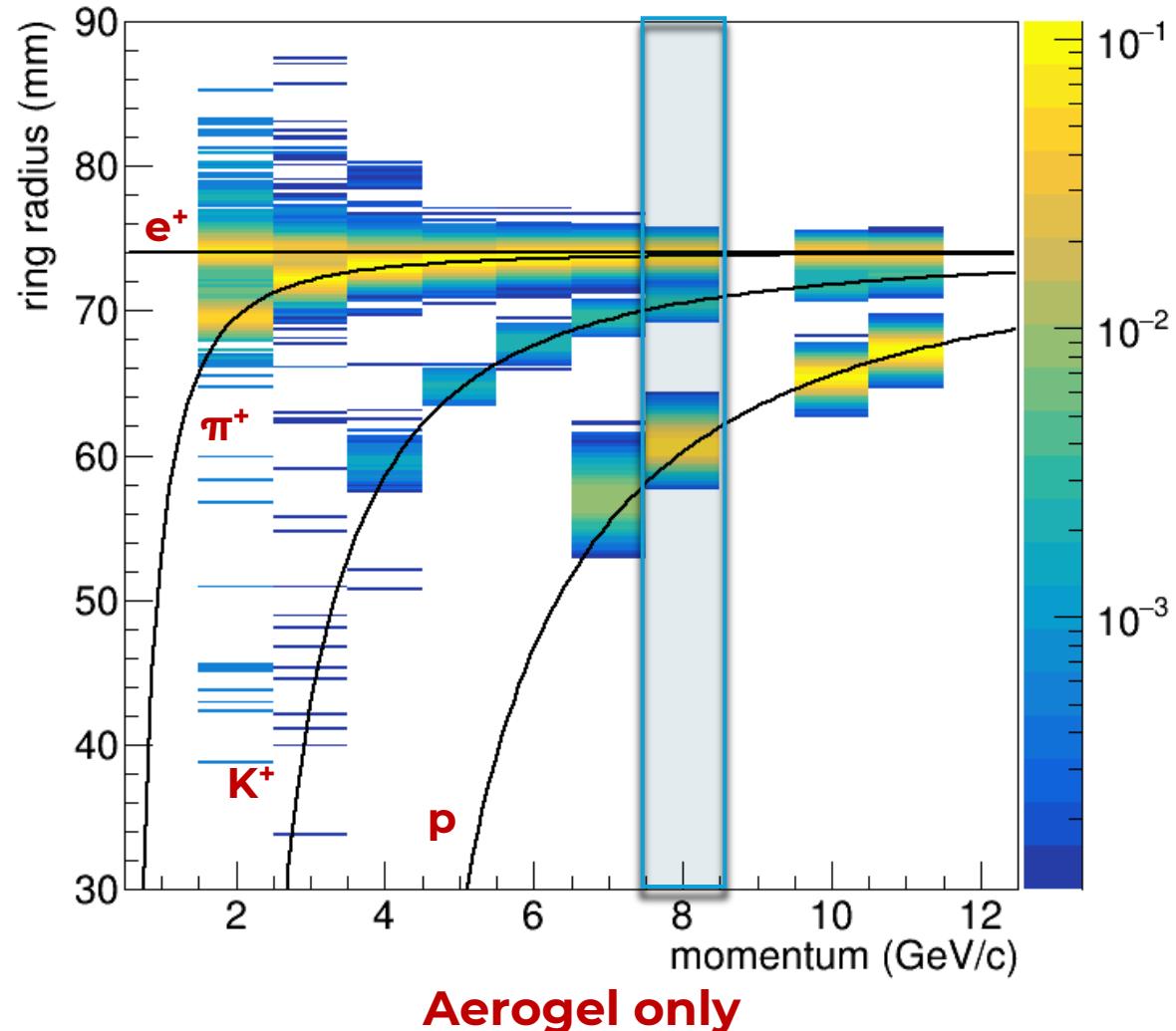


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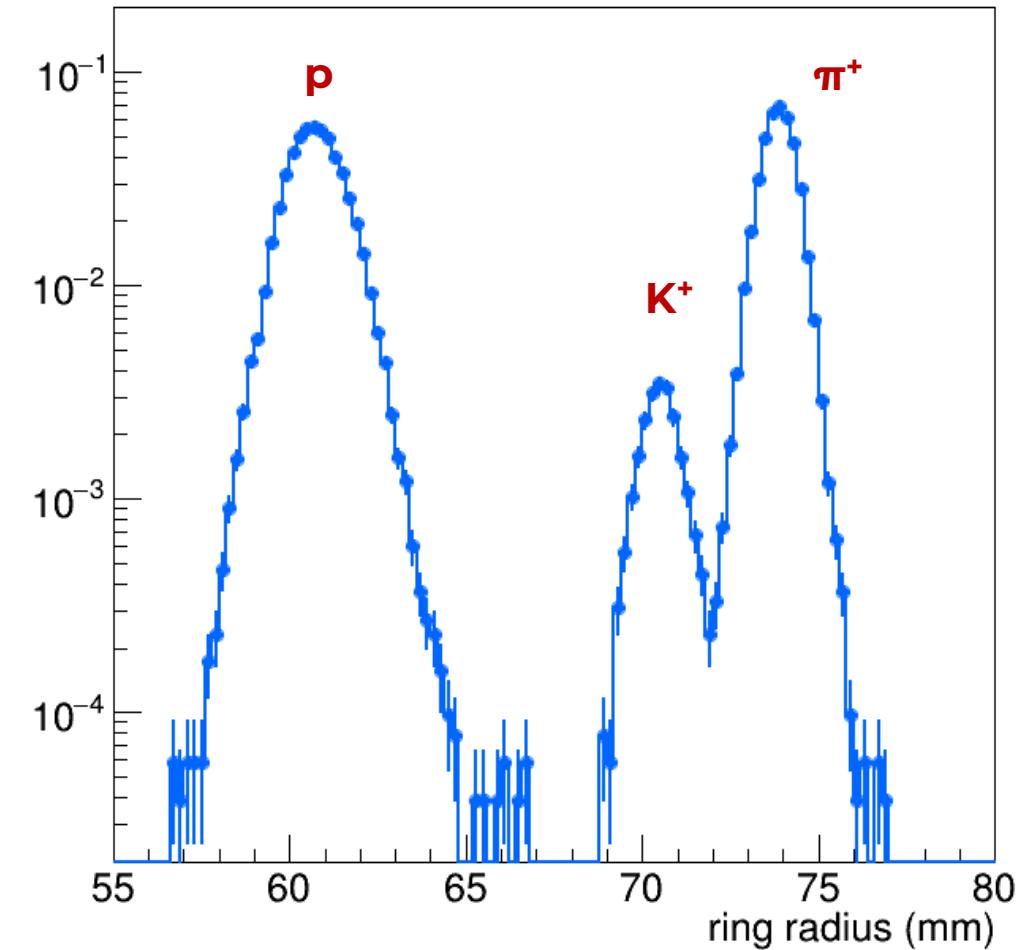


Positive beam momentum scan

Reconstructed radii vs. beam momentum

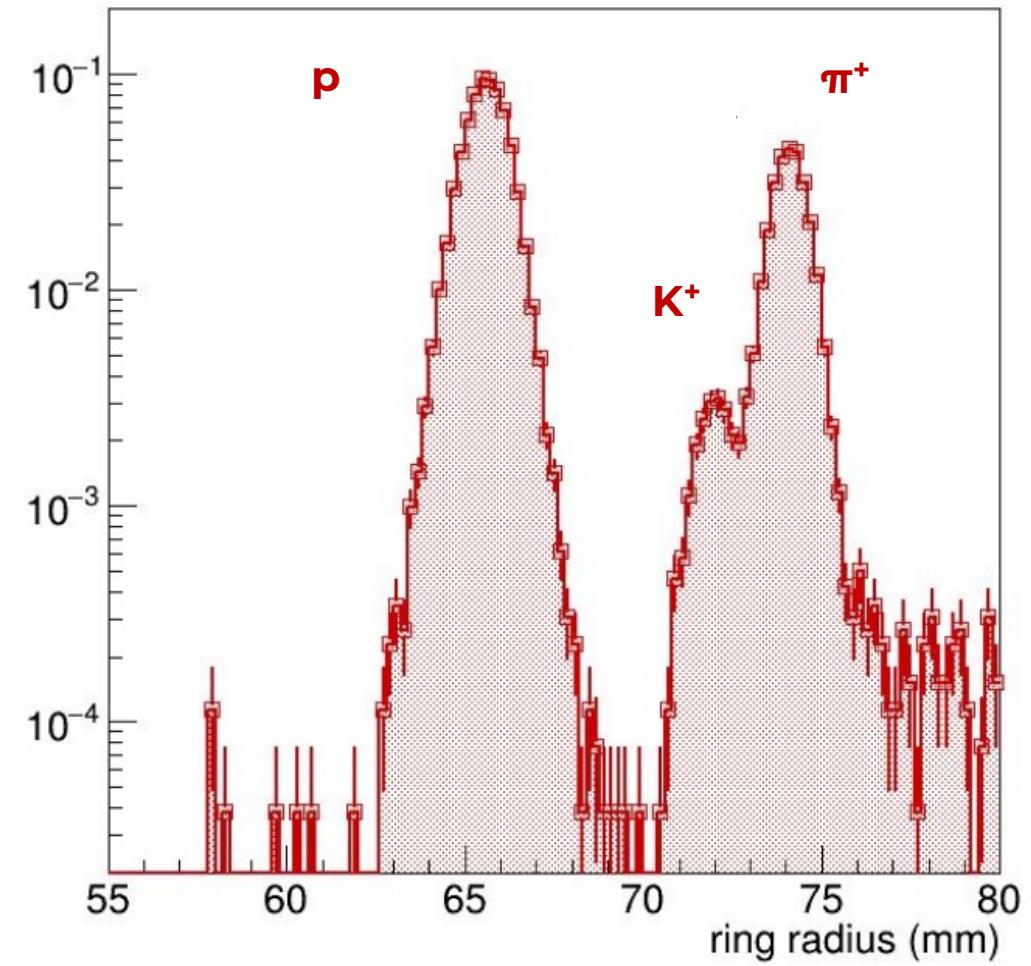
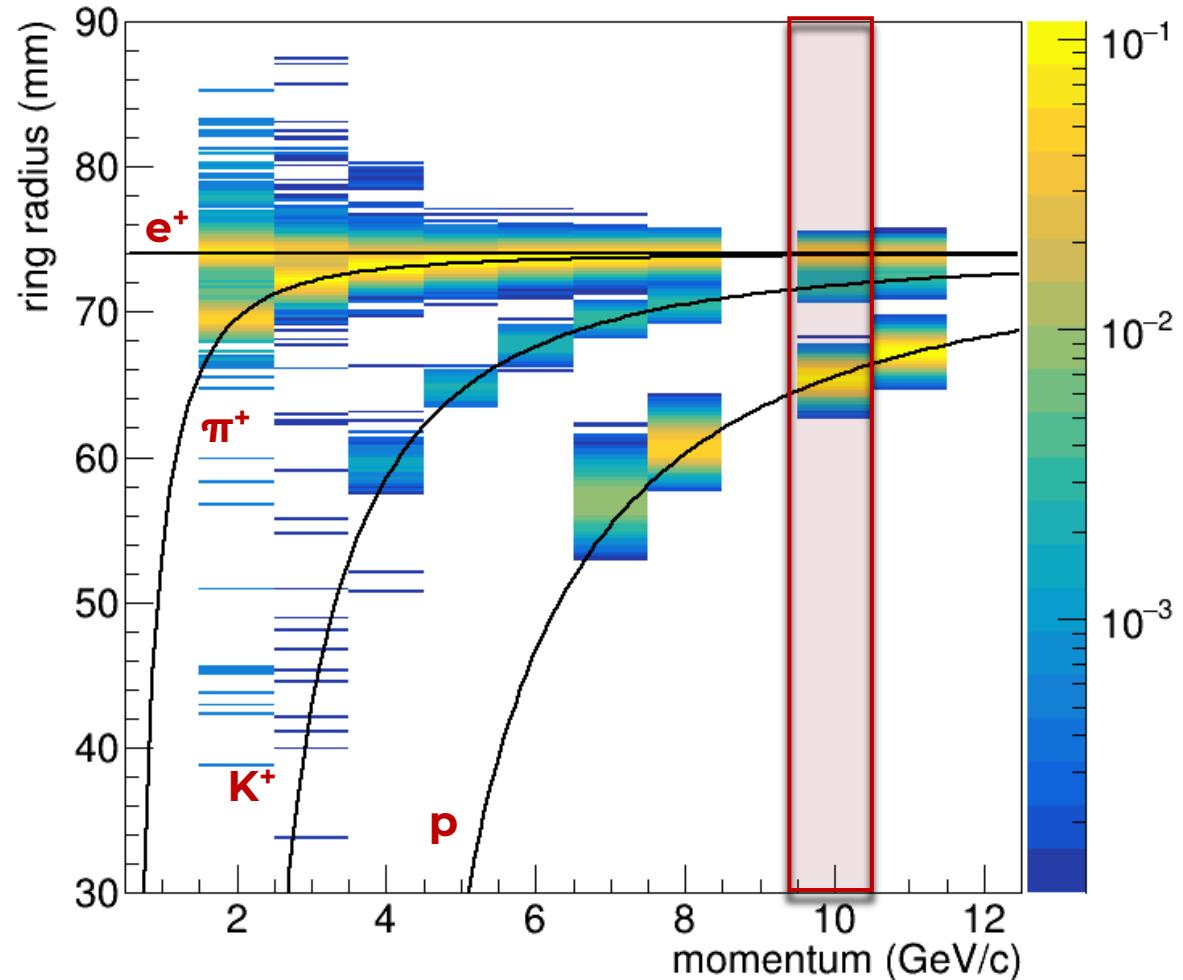


Aerogel only



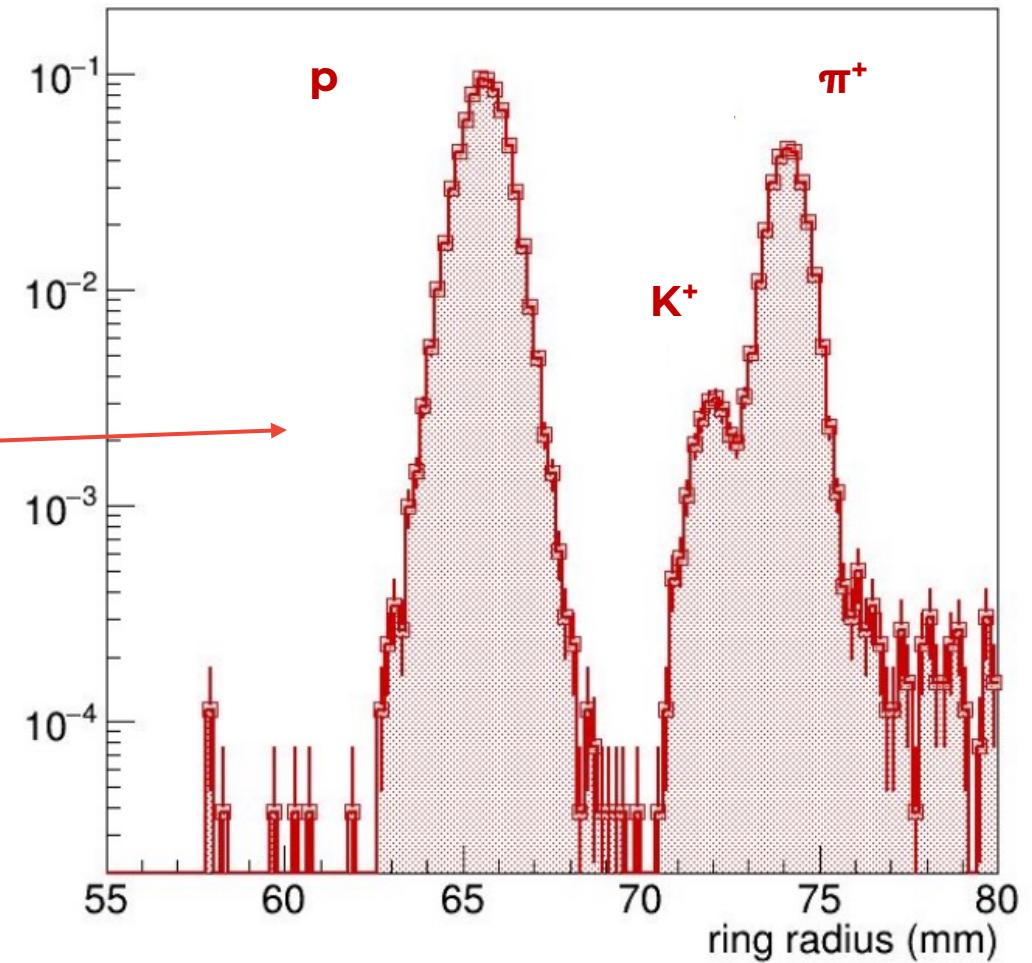
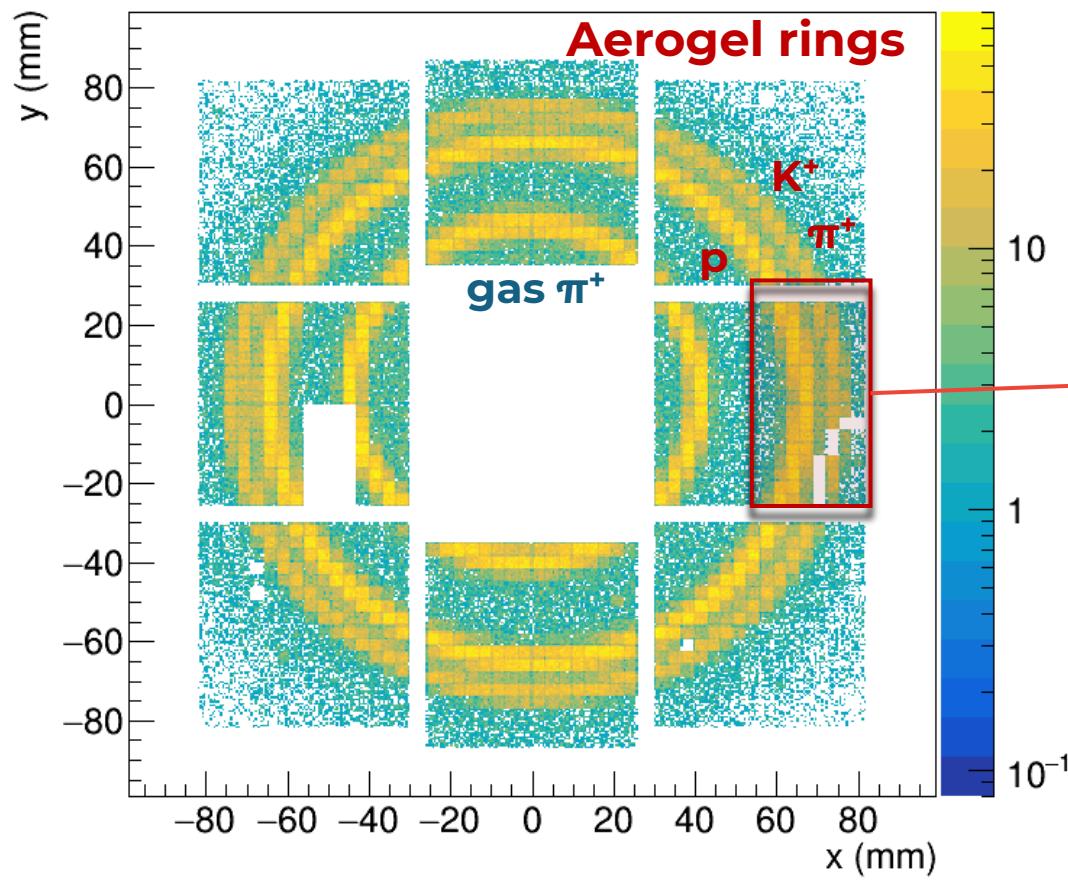
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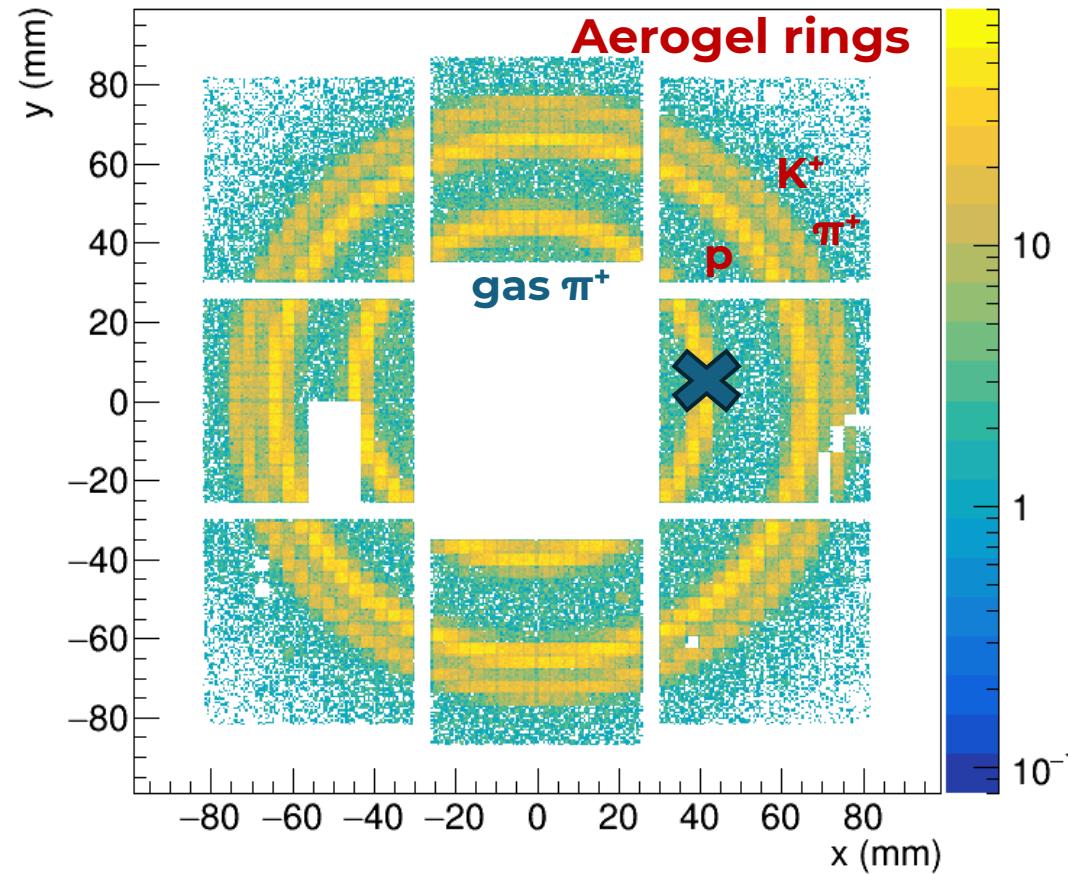


Positive beam momentum scan

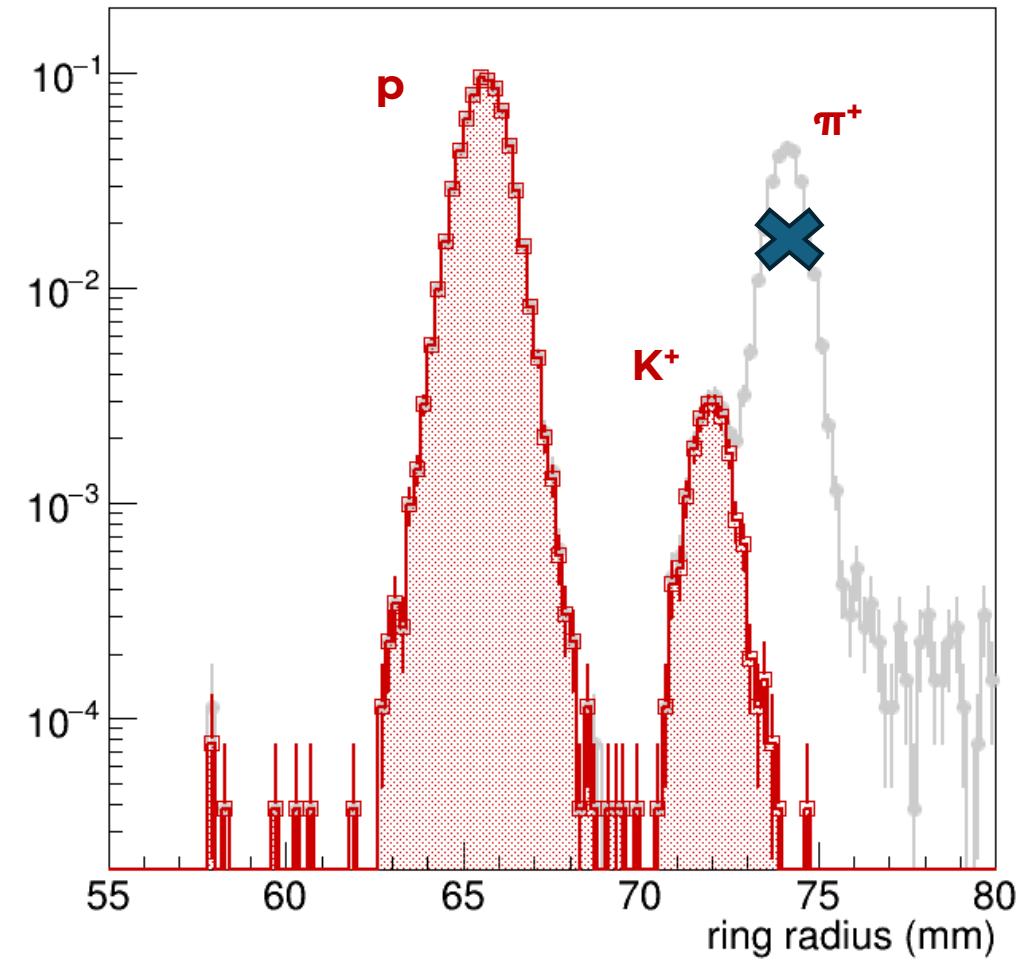
10 GeV/c positive beam with no selection applied



Positive beam momentum scan



10 GeV/c positive beam with π in gas as veto



Summary

Successfull **R&D** program to operate **SiPM** in mild **radiation** environment through **annealing**

400 cm² demonstrator with full **electronics** readout working with **dRICH prototype**

First SiPMs application for a RICH in HEP experiment

THANK YOU